

# Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

### FEATURES AND BENEFITS

- A<sup>2</sup>-SIL<sup>TM</sup> product—device features for safety-critical systems
- Automotive AEC-Q100 qualified
- Wide input voltage range, 3.8 to 36  $\rm V_{IN}$  operating range, 40  $\rm V_{IN}$  maximum
- 2.2 MHz buck or buck/boost pre-regulator (VREG: 5.35 V)
- Four internal linear regulators with foldback short-circuit protection
  - □ VUC: selectable output (3.3 V / 5.0 V) regulator for microcontroller
  - □ V5C: 5 V general purpose LDO regulator
  - □ V5P1 and V5P2: two LDO regulators (track VUC voltage) with short-to-battery protection for remote sensors
- Q&A Watchdog and Window Watchdog timer
- Floating gate drivers with charge pump for external isolator NFET control
- Control and diagnostic reporting through a serial peripheral interface (SPI)
- Logic enable input (ENB) for microprocessor control
- Ignition enable input (ENBAT)
- Frequency dithering and controlled slew rate help reduce EMI/EMC
- Undervoltage protection for all output rails
- Thermal shutdown protection
- –40°C to 150°C junction temperature range

#### **APPLICATIONS**

- Provides system power for (microcontroller/DSP, CAN, sensors, etc.) and high current isolation FET gate driver in automotive control modules, such as:
  - □ Electronic power steering (EPS)
  - □ Advanced braking systems (ABS)
  - □ Other automotive applications

## PACKAGE: 38-Pin eTSSOP (suffix LV)



#### DESCRIPTION

The ARG82801 is a power management IC that integrates a buck or buck/boost pre-regulator, four LDOs, and four floating gate drivers. The pre-regulator uses a buck or buck/boost topology to efficiently convert automotive battery voltages into a tightly regulated intermediate voltage complete with control, diagnostics, and protections.

The output of the pre-regulator supplies a 3.3 V or 5.0 V selectable 350 mA linear regulator, a 5 V/115 mA linear regulator, and two 120 mA protected linear regulators which track VUC output. Designed to supply power for microprocessors, sensors, and CAN transceivers, the ARG82801 is ideal for underhood applications.

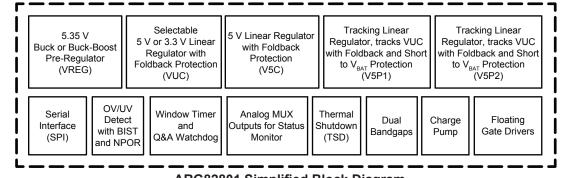
The independent floating gate drivers have the capability of controlling N-channel MOSFETs through SPI. These MOSFETs can be configured as phase or battery isolation devices in high current motor applications. An integrated charge pump allows the driver outputs to maintain the power MOSFETs in the on state over the full supply range with high phase-voltage slew rates.

Enable inputs to the ARG82801 include a logic level (ENB) and a high voltage (ENBAT). The ARG82801 also provides flexibility with disable function of the individual output rails through a serial peripheral interface (SPI).

Diagnostic outputs from the ARG82801 include a power-onreset output (NPOR) and a fault flag output (FFn) to alert the microprocessor that a fault has occurred. The microprocessor can read fault status through SPI. Dual bandgaps, one for regulation and one for fault checking, improve safety coverage and fault detection of the ARG82801.

The ARG82801 contains two types of watchdog functions: Q&A and Window Watchdog timer. The watchdog timer is activated once it receives a valid SPI command from a processor. The watchdog can be put into flash mode or be reset via secure SPI commands.

The ARG82801 is supplied in a low-profile (1.2 mm maximum height) 38-lead eTSSOP package (suffix LV) with exposed power pad.



ARG82801 Simplified Block Diagram





#### **SELECTION GUIDE**

Part Number	Package	Packing <sup>[1]</sup>	Lead Frame	
ARG82801KLVATR	38-pin eTSSOP with thermal pad	4000 pieces per 7-inch reel	100% matte tin	



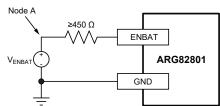
<sup>[1]</sup> Contact Allegro for additional packing options.

#### **ABSOLUTE MAXIMUM RATINGS**<sup>[2]</sup>

Characteristic	Symbol	Notes Rating	Unit
VIN	V <sub>VIN</sub>	-0.3 to 40	V
	N/	With current limiting resistor <sup>[3]</sup> -13 to 40	V
ENBAT	V <sub>ENBAT</sub>	-0.3 to 8	V
	I <sub>ENBAT</sub>	±75	mA
LX		-0.3 to V <sub>VIN</sub> + 0.3	3 V
	V <sub>LX</sub>	t < 250 ns -1.5	V
		t < 50 ns V <sub>VIN</sub> + 3	V
GU, GV, GW, GVBB	V <sub>GU</sub> , V <sub>GV</sub> , V <sub>GW</sub> , V <sub>GVBB</sub>	$V_{SX} - 0.3$ to $V_{SX}$ +	12 V
		-6 to V <sub>VIN</sub> + 5	V
SU, SV, SW, SVBB	$V_{SU}, V_{SV}, V_{SW}, V_{SVBB}$	Transient -18 to V <sub>VIN</sub> + 5	V
VCP1	V <sub>VCP1</sub>	$V_{VIN}$ – 0.3 to $V_{VIN}$ ·	+ 8 V
VCP2	V <sub>VCP2</sub>	V <sub>VIN</sub> – 0.3 to V <sub>VIN</sub> +	12 V
CP1C1	V	$V_{VIN} \ge 12V$ $V_{VIN} - 12 \text{ to } V_{VIN} +$	0.3 V
CPICI	V <sub>CP1C1</sub>	V <sub>VIN</sub> < 12V -0.3 to V <sub>VIN</sub> + 0.3	3 V
CP2C1	V <sub>CP2C1</sub>	$V_{VIN}$ – 0.3 to $V_{VCP1}$ -	+0.3 V
CP1C2	V <sub>CP1C2</sub>	V <sub>VIN</sub> - 0.3 to V <sub>VCP1</sub> -	+0.3 V
CP2C2	V <sub>CP2C2</sub>	$V_{CP1C2}$ – 0.3 to $V_{VCP2}$	+ 0.3 V
V5P1, V5P2	V <sub>V5P1</sub> , V <sub>V5P2</sub>	Independent of V <sub>VIN</sub> -1.0 to 40	V
All other pins		-0.3 to 7	V
Junction Temperature	TJ	-40 to 150	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to 150	°C

<sup>[2]</sup> Stresses beyond those listed in this table may cause permanent damage to the device. The absolute maximum ratings are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics table is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>[3]</sup> The higher ENBAT ratings (-13 V and 40 V) are measured at node A in the following circuit configuration:



#### THERMAL CHARACTERISTICS: May require derating at maximum conditions; see application information

Characteristic	Symbol	Test Conditions <sup>[1]</sup>	Value	Unit
Junction-to-Ambient Thermal Resistance	$R_{ extsf{ heta}JA}$	eTSSOP-38 (LV) package	30	°C/W

<sup>[1]</sup>Additional thermal information is available on the Allegro website.



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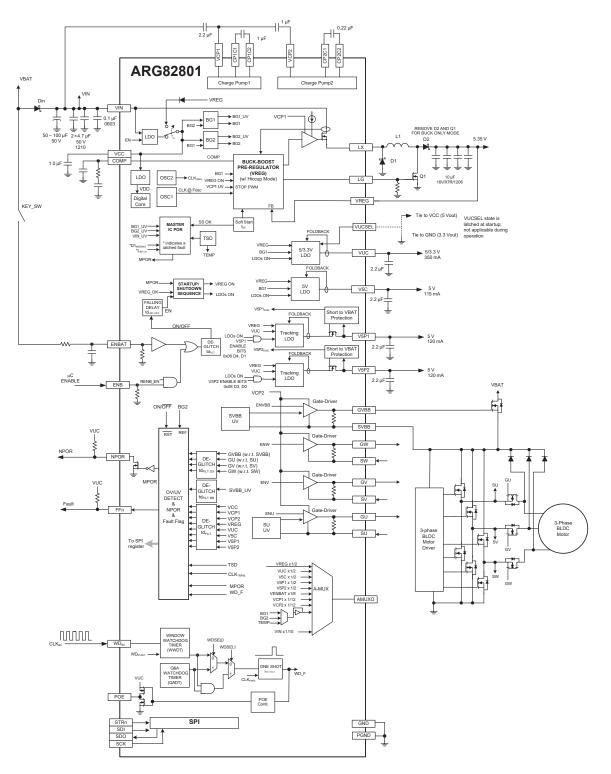
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FUNCTIONAL BLOCK DIAGRAM

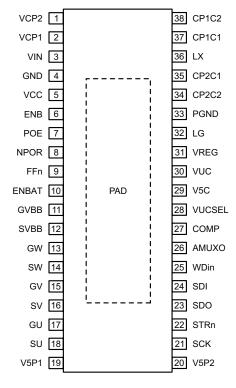




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## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI





Package LV, 38-Pin eTSSOP Pinout Diagram

Number	Name	Function
1	VCP2	Charge pump 2 reservoir capacitor connection
2	VCP1	Charge pump 1 reservoir capacitor connection
3	VIN	Input voltage pin
4	GND	Ground
5	VCC	Internal voltage regulator bypass capacitor pin
6	ENB	Logic enable input from a microcontroller or DSP
7	POE	Gate drive enable signal, goes low if a watchdog fault is detected
8	NPOR	Active low, open-drain regulator fault detection output
9	FFn	Fault Flag to microcontroller
10 11	ENBAT GVBB	Ignition enable input from the key/switch via a series resistor
		Battery line MOSFET gate drive
12	SVBB	Battery line MOSFET source reference
13	GW	W phase MOSFET gate drive
14	SW	W phase MOSFET source reference
15	GV	V phase MOSFET gate drive
16	SV	V phase MOSFET source reference
17	GU	U phase MOSFET gate drive
18	SU	U phase MOSFET source reference
19	V5P1	5 V protected regulator output which tracks VUC
20	V5P2	5 V protected regulator output which tracks VUC
21	SCK	SPI clock input from the microcontroller
22	STRn	SPI chip select input from the microcontroller
23	SDO	SPI data output to the microcontroller
24	SDI	SPI data input from the microcontroller
25	WDin	Watchdog refresh input from a microcontroller or DSP
26	AMUXO	Analog Multiplexer output
27	COMP	Error amplifier compensation network pin for the buck/boost pre-regulator
28	VUCSEL	VUC output voltage selection pin: 1 (High: should be tied to VCC), V <sub>VUC</sub> = 5 V 0 (Low: tied to GND), V <sub>VUC</sub> = 3.3 V
29	V5C	5 V regulator output
30	VUC	Selectable V <sub>OUT</sub> (5 V or 3.3 V by VUCSEL) regulator output
31	VREG	Voltage feedback input of the pre-regulator and supply input of the linear regulators
32	LG	Boost gate drive output for the buck/boost pre-regulator
33	PGND	Power ground
34	CP2C2	Charge pump 2 capacitor connection
35	CP2C1	Charge pump 2 capacitor connection
36	LX	Switching node for the buck/boost pre-regulator
37	CP1C1	Charge pump 1 capacitor connection
38	CP1C2	Charge pump 1 capacitor connection
_	PAD	Exposed thermal pad



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

## ELECTRICAL CHARACTERISTICS <sup>[1]</sup>: Valid at 3.8 V <sup>[4]</sup> ≤ V<sub>VIN</sub> ≤ 36 V, −40°C ≤ T<sub>J</sub> ≤ 150°C, V<sub>ENB</sub> = High or V<sub>ENBAT</sub> = High, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
GENERAL SPECIFICATIONS		· · · · · · · · · · · · · · · · · · ·		`		
Operating Input Voltage [2]		After $V_{\text{VIN}}$ > $V_{\text{VIN}(\text{START})}$ and VREG in regulating, buck-boost mode	3.8	13.5	36	V
Operating Input Voltage <sup>[2]</sup>	V <sub>VIN</sub>	After $V_{VIN} > V_{VIN(START)}$ and VREG in regulating, buck mode	5.5	13.5	36	V
VIN UVLO Start Voltage	V <sub>VIN(START)</sub>	V <sub>VIN</sub> rising	4.55	4.8	5.05	V
VIN UVLO Stop Voltage	V <sub>VIN(STOP)</sub>	V <sub>VIN</sub> falling	3.25	3.5	3.75	V
VIN UVLO Hysteresis	V <sub>VIN(HYS)</sub>	V <sub>VIN(START)</sub> – V <sub>VIN(STOP)</sub>	_	1.3	_	V
	IQ	V <sub>VIN</sub> = 13.5 V, V <sub>VREG</sub> = 5.6 V (no PWM)	_	13	_	mA
VIN Supply Quiescent Current [1]	I <sub>Q(SLEEP)</sub>	$V_{VIN}$ = 13.5 V, V <sub>ENBAT</sub> = Low and V <sub>ENB</sub> = Low, T <sub>J</sub> = 25°C	_	_	13	μA
PWM SWITCHING FREQUENC	Y AND DITHERI	NG		·		
Switching Frequency	f <sub>osc</sub>	Dithering off	2.0	2.2	2.4	MHz
Frequency Dithering	Δf <sub>OSC</sub>	As a percent of f <sub>OSC</sub>	_	±10	_	%
VIN Dith aring Otant Thread and [2]	V <sub>VIN(DITHER,ON)</sub>	V <sub>VIN</sub> rising	8.5	9.0	9.5	V
VIN Dithering Start Threshold [2]		V <sub>VIN</sub> falling	_	17	_	V
VIN Dith arises Of a Thready I [2]	V <sub>VIN(DITHER,OFF)</sub>	V <sub>VIN</sub> falling	7.8	8.3	8.8	V
VIN Dithering Stop Threshold <sup>[2]</sup>		V <sub>VIN</sub> rising	_	18	_	V
CHARGE PUMP (VCP1 AND VC	P2)	·				
	V <sub>VCP1</sub>	$V_{VCP1} - V_{VIN}, V_{VIN} \ge 9 V, I_{VCP1} > -5 mA,$ buck mode	4.1	6.6	_	V
VCP1 Output Voltage		$V_{VCP1} - V_{VIN}, ~5.5~V < V_{VIN} \le 9~V,~I_{VCP1} > -5~mA,$ buck mode	3.6	4.4	_	V
		$V_{VCP1} - V_{VIN}$ , 3.8 V < $V_{VIN} \le 5.5$ V, V <sub>REG</sub> = 5.35 V, I <sub>VCP1</sub> > -5 mA, buck-boost mode	3.0	3.8	-	V
		$V_{VCP2} - V_{VIN}$ , $V_{VIN} > 9$ V, $I_{VCP2} > -1$ mA, buck mode	9	10	-	V
VCP2 Output Voltage	V <sub>VCP2</sub>	$V_{VCP2} - V_{VIN}$ , 5.5 V < $V_{VIN} \le$ 9 V, $I_{VCP2} > -1$ mA, buck mode	8	10	_	V
		$V_{VCP2} - V_{VIN}$ , 3.8 V < $V_{VIN} \le 5.5$ V, $V_{VREG} = 5.35$ V, $I_{VCP2} > -1$ mA, buck-boost mode	6.6	9.5	_	V
Switching Frequency	f <sub>SW(CP)</sub>		_	65	_	kHz
VCC PIN VOLTAGE		· · · · · · · · · · · · · · · · · · ·				
Output Voltage	V <sub>VCC</sub>	V <sub>VREG</sub> = 5.35 V	_	4.4	_	V
THERMAL PROTECTION						
Thermal Shutdown Threshold [2]	T <sub>TSD</sub>	T <sub>J</sub> rising	165	_	_	°C
Thermal Shutdown Hysteresis [2]	T <sub>HYS</sub>		_	15	_	°C

<sup>[1]</sup> For input and output current specifications, negative current is defined as coming out of the node or pin (sourcing), positive current is defined as going into the node or pin (sinking).

<sup>[2]</sup> Ensured by design and characterization, not production tested.

<sup>[3]</sup> Specifications at 25°C or 85°C are guaranteed by design and characterization, not production tested.



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## ELECTRICAL CHARACTERISTICS (continued) <sup>[1]</sup>: Valid at 3.8 V <sup>[4]</sup> $\leq$ V<sub>VIN</sub> $\leq$ 36 V, -40°C $\leq$ T<sub>J</sub> $\leq$ 150°C, V<sub>ENB</sub> = High or V<sub>ENBAT</sub> = High, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
OUTPUT VOLTAGE SPECIFICAT	IONS					
Pre-Regulator Output Voltage [2]	V <sub>VREG</sub>	V <sub>VIN</sub> = 13.5 V, 0.1 A < I <sub>VREG</sub> < 1.2 A	5.25	5.35	5.45	V
PULSE-WIDTH MODULATION (P	WM)	·				
PWM Ramp Offset	V <sub>PWM(OFFS)</sub>	V <sub>COMP</sub> for 0% duty cycle	-	480	_	mV
LX Rising Slew Rate [2]	SR <sub>LXRISE</sub>	V <sub>VIN</sub> = 13.5 V, 10% to 90%, I <sub>VREG</sub> = 1 A	-	1.4	_	V/ns
LX Falling Slew Rate [2]	SR <sub>LXFALL</sub>	V <sub>VIN</sub> = 13.5 V, 90% to 10%, I <sub>VREG</sub> = 1 A	-	1.5	-	V/ns
Buck Minimum On-Time	t <sub>ON(BUCK,MIN)</sub>		-	85	160	ns
Buck Maximum Duty Cycle	D <sub>BUCK(MAX)</sub>	V <sub>VIN</sub> < 7.8 V	-	-	100	%
Boost Maximum Duty Cycle	D <sub>BST(MAX)</sub>	After V <sub>VIN</sub> > V <sub>VIN(START)</sub> , and VREG in regulating, V <sub>VIN</sub> = 3.8 V	-	65	_	%
COMP to LX Current Gain	gm <sub>POWER</sub>		-	4.57	-	A/V
Slope Compensation [2]	S <sub>E</sub>		1.1	1.62	2.15	A/µs
INTERNAL MOSFET			÷.			
	R <sub>DS(on)</sub>	$V_{VIN}$ = 13.5 V, T <sub>J</sub> = -40°C <sup>[2]</sup> , I <sub>DS</sub> = 0.1 A	-	60	90	mΩ
MOSFET On Resistance		V <sub>VIN</sub> = 13.5 V, T <sub>J</sub> = 25°C <sup>[3]</sup> , I <sub>DS</sub> = 0.1 A	-	95	115	mΩ
		V <sub>VIN</sub> = 13.5 V, T <sub>J</sub> = 150°C, I <sub>DS</sub> = 0.1 A	-	160	190	mΩ
		$V_{ENBAT} \le 2.2 \text{ V}, V_{ENB} = \text{Low}, V_{LX} = 0 \text{ V}, V_{VIN} = 16 \text{ V}, -40^{\circ}\text{C} < \text{T}_{J} < 85^{\circ}\text{C}$ <sup>[3]</sup>	-	_	10	μA
MOSFET Leakage Current	I <sub>FET(LKG)</sub>	$V_{\text{ENBAT}} \le 2.2 \text{ V}, V_{\text{ENB}} \le \text{Low}, V_{\text{LX}} = 0 \text{ V},$ $V_{\text{VIN}} = 16 \text{ V}, -40^{\circ}\text{C} < \text{T}_{\text{J}} < 150^{\circ}\text{C}$	-	50	150	μA
ERROR AMPLIFIER						
Open Loop Voltage Gain	A <sub>VOL</sub>		-	60	-	dB
Transconductorso		V <sub>SS</sub> (internal signal) = 750 mV	520	720	920	μA/V
Transconductance	gm <sub>EA</sub>	V <sub>SS</sub> (internal signal) = 500 mV	260	360	460	μA/V
Output Current	I <sub>O(EA)</sub>		-	±75	_	μA
		V <sub>VIN</sub> < 8.5 V	1.2	1.52	2.1	V
Maximum Output Voltage	V <sub>O(EA,MAX)</sub>	V <sub>VIN</sub> > 9.5 V	0.9	1.22	1.7	V
Minimum Output Voltage	V <sub>O(EA,MIN)</sub>		_	-	300	mV
COMP Pull-Down Resistance	R <sub>COMP</sub>	HICCUP = 1 or FAULT = 1 or V <sub>ENBAT</sub> = Low and V <sub>ENB</sub> = Low	_	1	_	kΩ

<sup>[1]</sup> For input and output current specifications, negative current is defined as coming out of the node or pin (sourcing), positive current is defined as going into the node or pin (sinking).

<sup>[2]</sup> Ensured by design and characterization, not production tested.

<sup>[3]</sup> Specifications at 25°C or 85°C are guaranteed by design and characterization, not production tested.

<sup>[4]</sup> The lowest operating voltage is only valid if the conditions  $V_{VIN} > V_{VIN(START)}$  and  $V_{VCP} - V_{VIN} > V_{VCP(UV,H)}$  and  $V_{VREG}$  in regulating are satisfied before  $V_{VIN}$  is reduced.



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## ELECTRICAL CHARACTERISTICS (continued) <sup>[1]</sup>: Valid at 3.8 V <sup>[4]</sup> $\leq$ V<sub>VIN</sub> $\leq$ 36 V, -40°C $\leq$ T<sub>J</sub> $\leq$ 150°C, V<sub>ENB</sub> = High or V<sub>ENBAT</sub> = High, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
BOOST MOSFET (LG) GATE DR	IVER	•				
LG High Output Voltage	V <sub>LG(ON)</sub>	V <sub>VIN</sub> = 6 V, V <sub>VREG</sub> = 5.35 V	4.6	_	5.35	V
LG Low Output Voltage	V <sub>LG(OFF)</sub>	V <sub>VIN</sub> = 13.5 V, V <sub>VREG</sub> = 5.35 V	-	0.2	0.4	V
LG Source Current <sup>[1]</sup>	I <sub>LG(ON)</sub>	V <sub>VIN</sub> = 6 V, V <sub>VREG</sub> = 5.35 V, V <sub>LG</sub> = 1 V	-	-300	_	mA
LG Sink Current <sup>[1]</sup>	I <sub>LG(OFF)</sub>	V <sub>VIN</sub> =13.5 V, V <sub>VREG</sub> = 5.35 V, V <sub>LG</sub> = 1 V	-	150	_	mA
SOFT-START						
SS Ramp Time <sup>[2]</sup>	t <sub>ss</sub>		-	900	_	μs
SS PWM Frequency Foldback		$0 \text{ V} \le \text{V}_{\text{VREG}} < 0.67 \text{ V}$ typical	-	f <sub>OSC</sub> /8	-	-
	£	$0.67 \text{ V} \leq \text{V}_{\text{VREG}} < 1.34 \text{ V}$ typical	-	f <sub>OSC</sub> /4	_	-
	f <sub>SW(SS)</sub>	$1.34 \text{ V} \leq \text{V}_{\text{VREG}} < 2.68 \text{ V}$ typical	-	f <sub>OSC</sub> /2	_	-
		V <sub>VREG</sub> ≥ 2.68 V typical	-	f <sub>OSC</sub>	_	-
HICCUP MODE						
Hiccup Enable Delay Time [2]	t <sub>HIC(EN)</sub>		-	230	_	μs
Hiccup Recovery Time [2]	t <sub>HIC(REC)</sub>		-	930	_	μs
		$V_{VREG}$ < 1.3 $V_{TYP}$ , $V_{COMP}$ = $V_{O(EA,MAX)}$	-	32	_	PWM cycles
Hiccup OCP PWM Counts	t <sub>HIC(OCP)</sub>	$V_{VREG}$ > 1.3 $V_{TYP}$ , $V_{COMP}$ = $V_{O(EA,MAX)}$	-	120	_	PWM cycles
CURRENT PROTECTIONS						
Pulsa by Pulsa Current Limit		V <sub>VIN</sub> < 8.5 V	3.83	4.2	4.77	A
Pulse-by-Pulse Current Limit	ILIM(ton,min)	V <sub>VIN</sub> > 9.5 V	2.49	2.8	3.11	A
LX Short-Circuit Current Limit	I <sub>LIM(LX)</sub>	Latched fault after 2 <sup>nd</sup> detection	5.3	7.1	_	A

<sup>[1]</sup> For input and output current specifications, negative current is defined as coming out of the node or pin (sourcing), positive current is defined as going into the node or pin (sinking).

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Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
MISSING ASYNCHRONOUS DIODE	(D1) PROTEC	CTION	· · ·			
Detection Level	V <sub>D(OPEN)</sub>		-1.9	-1.4	-1.0	V
Time Filtering <sup>[2]</sup>	t <sub>D(OPEN)</sub>		50	-	250	ns
VUC, V5C, V5P1, V5P2 LINEAR REC	GULATORS		·	·		
VUC Accuracy and Load Regulation (5 $V_{OUT}$ )	V <sub>VUC5</sub>	10 mA < I <sub>VUC</sub> < 350 mA, V <sub>VREG</sub> = 5.25 V, VUCSEL = 1	4.9	5.0	5.1	V
VUC Accuracy and Load Regulation (3.3 $V_{\text{OUT}})$	V <sub>VUC33</sub>	10 mA < I <sub>VUC</sub> < 350 mA, V <sub>VREG</sub> = 5.25 V, VUCSEL = 0	3.23	3.30	3.37	V
VUC Output Capacitance Range <sup>[2]</sup>	C <sub>OUT(VUC)</sub>		1.0	-	15	μF
V5C Accuracy and Load Regulation	V <sub>V5C</sub>	5 mA < I $_{\rm V5C}$ < 115 mA, V $_{\rm VREG}$ = 5.25 V	4.9	5.0	5.1	V
V5C Output Capacitance Range <sup>[2]</sup>	C <sub>OUT(V5C)</sub>		1.0	-	15	μF
V5P1 Accuracy and Load Regulation (5 $V_{OUT}$ )	V <sub>V5P1</sub>	5 mA < I <sub>V5P1</sub> < 120 mA, V <sub>VREG</sub> = 5.25 V	4.9	5.0	5.1	V
V5P1 Output Capacitance Range <sup>[2]</sup>	C <sub>OUT(V5P1)</sub>		1.0	-	15	μF
V5P2 Accuracy and Load Regulation (5 $V_{OUT}$ )	V <sub>V5P2</sub>	5 mA < I <sub>V5P2</sub> < 120 mA, V <sub>VREG</sub> = 5.25 V	4.9	5.0	5.1	V
V5P2 Output Capacitance Range [2]	C <sub>OUT(V5P2)</sub>		1.0	-	15	μF
V5Px/VUC Tracking Ratio	TRACK <sub>V5Px/VUC</sub>	$V_{VUC}$ = 3.3 V, $V_{V5Px}$ / $V_{3V3}$ , VUCSEL = 0	1.500	1.515	1.530	V/V
V5Px Tracking Accuracy, $V_{VUC}$ = 3.3 V	TRACK <sub>33</sub>	$I_{V5Px} = I_{VUC} = 60 \text{ mA}, \text{ VUCSEL} = 0$	-0.66	-	0.66	%
V5Px Tracking Accuracy, $V_{VUC}$ = 5 V	V <sub>TRACK(5V)</sub>	$I_{V5Px} = I_{VUC} = 60 \text{ mA}, \text{ VUCSEL} = 1$	-25	-	25	mV
VUC OVERCURRENT PROTECTION	N					
VUC Current Limit <sup>[1]</sup>	I <sub>VUC(LIM)</sub>		-385	-570	-800	mA
VUC Foldback Current <sup>[1]</sup>	I <sub>VUC(FBK)</sub>	V <sub>VUC</sub> = 0 V	-60	-170	-250	mA
<b>V5C OVERCURRENT PROTECTION</b>	l					
V5C Current Limit <sup>[1]</sup>	I <sub>V5C(LIM)</sub>		-120	-180	-250	mA
V5C Foldback Current <sup>[1]</sup>	I <sub>V5C(FBK)</sub>	V <sub>V5C</sub> = 0 V	-15	-60	-125	mA
<b>V5P1 OVERCURRENT PROTECTIO</b>	N					
V5P1 Current Limit <sup>[1]</sup>	I <sub>V5P1(LIM)</sub>		-135	-230	-350	mA
V5P1 Foldback Current <sup>[1]</sup>	I <sub>V5P1(FBK)</sub>	V <sub>V5P1</sub> = 0 V	-20	-60	-125	mA
V5P2 OVERCURRENT PROTECTIO						
V5P2 Current Limit <sup>[1]</sup>	I <sub>V5P2(LIM)</sub>		-135	-230	-350	mA
V5P2 Foldback Current <sup>[1]</sup>	I <sub>V5P2(FBK)</sub>	V <sub>V5P2</sub> = 0 V	-20	-60	-125	mA

<sup>[1]</sup> For input and output current specifications, negative current is defined as coming out of the node or pin (sourcing), positive current is defined as going into the node or pin (sinking).

<sup>[2]</sup> Ensured by design and characterization, not production tested.

<sup>[3]</sup> Specifications at 25°C or 85°C are guaranteed by design and characterization, not production tested.



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

## ELECTRICAL CHARACTERISTICS (continued) <sup>[1]</sup>: Valid at 3.8 V <sup>[4]</sup> $\leq$ V<sub>VIN</sub> $\leq$ 36 V, -40°C $\leq$ T<sub>J</sub> $\leq$ 150°C, V<sub>ENB</sub> = High or V<sub>ENBAT</sub> = High, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
VUC, V5C, V5P1, AND V5P2 START	UP TIMING		0			
VUC Startup Time (5 V <sub>OUT</sub> ) <sup>[2]</sup>	t <sub>VUC5(START)</sub>	$C_{VUC} \le 2.9 \ \mu\text{F}$ , Load = 33 $\Omega \pm 5\%$ (152 mA), VUCSEL = 1	-	_	1.0	ms
VUC Startup Time (3.3 V <sub>OUT</sub> ) <sup>[2]</sup>	t <sub>VUC33(START)</sub>	$C_{VUC} \le 2.9 \ \mu\text{F}$ , Load = 33 $\Omega \pm 5\%$ (100 mA), VUCSEL = 0	-	_	1.0	ms
V5C Startup Time [2]	t <sub>V5C(START)</sub>	C <sub>V5C</sub> ≤ 2.9 μF, Load = 100 Ω ±5% (50 mA)	_	_	1.0	ms
V5P1 Startup Time <sup>[2]</sup>	t <sub>V5P1(START)</sub>	C <sub>V5P1</sub> ≤ 2.9 μF, Load = 100 Ω ±5%	-	_	1.0	ms
V5P2 Startup Time <sup>[2]</sup>	t <sub>VP2(START)</sub>	C <sub>V5P2</sub> ≤ 2.9 μF, Load = 100 Ω ±5%	-	_	1.0	ms
IGNITION ENABLE (ENBAT) INPUT					~	
	V <sub>ENBAT(H)</sub>	V <sub>ENBAT</sub> rising	2.9	3.1	3.5	V
ENBAT Thresholds	V <sub>ENBAT(L)</sub>	V <sub>ENBAT</sub> falling	2.2	2.6	2.9	V
ENBAT Hysteresis	V <sub>ENBAT(HYS)</sub>	V <sub>ENBAT(H)</sub> – V <sub>ENBAT(L)</sub>	-	500	_	mV
ENBAT Bias Current <sup>[1]</sup>		V <sub>ENBAT</sub> = 0.8 V via a 1 kΩ series resistor	-	_	5	μA
	I <sub>ENBAT(BIAS)</sub>	$V_{ENBAT}$ = 5.5 V via a 1 kΩ series resistor	_	50	100	μA
		V <sub>ENBAT</sub> = 20 V via a 1 kΩ series resistor	-	_	2	mA
ENBAT Pulldown Resistance	R <sub>ENBAT</sub>	V <sub>ENBAT</sub> < 1.2 V	-	600	_	kΩ
LOGIC ENABLE (ENB) INPUT						
	V <sub>ENB(H)</sub>	V <sub>ENB</sub> rising	_	_	2.0	V
ENB Thresholds	V <sub>ENB(L)</sub>	V <sub>ENB</sub> falling	0.8	_	_	V
ENB Bias Current <sup>[1]</sup>	I <sub>ENB(IN)</sub>	V <sub>ENB</sub> = 3.3 V	-	_	175	μA
ENB Resistance	R <sub>ENB</sub>		-	60	_	kΩ
ENB/ENBAT FILTER/DEGLITCH	<u>.</u>			·		
Enable Filter/Deglitch Time	t <sub>d(EN)</sub>		10	15	20	μs
VUC, V5C, V5P1, AND V5P2 UNDEI	RVOLTAGE PF	ROTECTION THRESHOLDS			~	
VUC (5 V <sub>OUT</sub> ), V5C, V5P1, and V5P2	V <sub>V5(UV,H)</sub>	V <sub>V5</sub> rising, VUCSEL = 1	-	4.68	_	V
Undervoltage Thresholds	V <sub>V5(UV,L)</sub>	V <sub>V5</sub> falling, VUCSEL = 1	4.50	4.65	4.80	V
VUC (3.3 V <sub>OUT</sub> ) Undervoltage	V <sub>V33(UV,H)</sub>	V <sub>V33</sub> rising, VUCSEL = 0	-	3.12	_	V
Thresholds	V <sub>V33(UV,L)</sub>	V <sub>V33</sub> falling, VUCSEL = 0	2.8	3.1	3.19	V
VUC (5 V <sub>OUT</sub> ), V5C, V5P1, and V5P2 Undervoltage Hysteresis	V <sub>V5(UV,HYS)</sub>	$V_{V5(UV,H)} - V_{V5(UV,L)}$	-	30	_	mV
VUC (3.3 V <sub>OUT</sub> ) Undervoltage Hysteresis	V <sub>V33(UV,HYS)</sub>	V <sub>V33(UV,H)</sub> – V <sub>V33(UV,L)</sub>	-	20	_	mV

<sup>[1]</sup> For input and output current specifications, negative current is defined as coming out of the node or pin (sourcing), positive current is defined as going into the node or pin (sinking).

<sup>[2]</sup> Ensured by design and characterization, not production tested.

<sup>[3]</sup> Specifications at 25°C or 85°C are guaranteed by design and characterization, not production tested.



## ELECTRICAL CHARACTERISTICS (continued) <sup>[1]</sup>: Valid at 3.8 V <sup>[4]</sup> $\leq$ V<sub>VIN</sub> $\leq$ 36 V, -40°C $\leq$ T<sub>J</sub> $\leq$ 150°C, V<sub>ENB</sub> = High or V<sub>ENBAT</sub> = High, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
VUC, V5C, V5P1, AND V5P2 OVER	OLTAGE PRO	TECTION THRESHOLDS			~	
VUC (5 V <sub>OUT</sub> ), V5C, V5P1, and V5P2	V <sub>V5(OV,H)</sub>	V <sub>V5</sub> rising, VUCSEL = 1	5.15	5.33	5.5	V
Overvoltage Thresholds	V <sub>V5(OV,L)</sub>	V <sub>V5</sub> falling, VUCSEL = 1	-	5.30	_	V
VUC (3.3 V <sub>OUT</sub> ) Overvoltage	V <sub>V33(OV,H)</sub>	V <sub>V33</sub> rising, VUCSEL = 0	3.41	3.51	3.62	V
Thresholds	V <sub>V33(OV,L)</sub>	V <sub>V33</sub> falling, VUCSEL = 0	-	3.49	_	V
VUC (5 V <sub>OUT</sub> ), V5C, V5P1, and V5P2 Overvoltage Hysteresis	V <sub>V5(OV,HYS)</sub>	$V_{V5(OV,H)} - V_{V5(OV,L)}$	-	30	_	mV
VUC (3.3 V <sub>OUT</sub> ) Overvoltage Hysteresis	V <sub>V33(OV,HYS)</sub>	V <sub>V33(OV,H)</sub> – V <sub>V33(OV,L)</sub>	-	20	_	mV
V5Px Output Disconnect Threshold	V <sub>V5PX(DISC)</sub>	V <sub>V5PX</sub> rising	_	7.2	_	V
VREG, VCPX, AND BG THRESHOL						
VREG Non-Latching Overvoltage	V <sub>VREG(OV,H)</sub>	V <sub>VREG</sub> rising, LX PWM disabled	5.70	5.95	6.20	V
Threshold	V <sub>VREG(OV,L)</sub>	V <sub>VREG</sub> falling, LX PWM enabled	-	5.85	_	V
VREG Non-Latching Overvoltage Hysteresis	V <sub>VREG(OV,HYS)</sub>	$V_{VREG(OV,H)} - V_{VREG(OV,L)}$	-	100	_	mV
VREG Undervoltage Thresholds	V <sub>VREG(UV,H)</sub>	V <sub>VREG</sub> rising, triggers rise of VUC linear regulator	4.14	4.38	4.62	V
Ū.	V <sub>VREG(UV,L)</sub>	V <sub>VREG</sub> falling	-	4.28	_	V
VREG Undervoltage Hysteresis	V <sub>VREG(UV,HYS)</sub>	V <sub>VREG(UV,H)</sub> – V <sub>VREG(UV,L)</sub>	-	100	_	mV
VCP1 Overvoltage Thresholds [2]	V <sub>VCP1(OV,H)</sub>	V <sub>VCP1</sub> rising (w.r.t. V <sub>VIN</sub> )	11.0	12.5	14.0	V
VCD1 Lindervoltege Threeholde	V <sub>VCP1(UV,H)</sub>	V <sub>VCP1</sub> rising, PWM enabled (w.r.t. V <sub>VIN</sub> )	2.9	3.1	3.35	V
VCP1 Undervoltage Thresholds	V <sub>VCP1(UV,L)</sub>	$V_{VCP1}$ falling, PWM disabled (w.r.t. $V_{VIN}$ )	-	2.8	_	V
VCP1 Undervoltage Hysteresis	V <sub>VCP1(UV,HYS)</sub>	V <sub>VCP1(UV,H)</sub> - V <sub>VCP1(UV,L)</sub>	-	400	_	mV
VCP2 Undervoltage Thresholds	V <sub>VCP2(UV,H)</sub>	$V_{VCP2}$ rising, PWM enabled (w.r.t. $V_{VIN}$ )	5.95	6.3	6.65	V
VCP2 Undervoltage Thresholds	V <sub>VCP2(UV,L)</sub>	$V_{VCP2}$ falling, PWM disabled (w.r.t. $V_{VIN}$ )	-	5.1	-	V
VCP2 Undervoltage Hysteresis	V <sub>VCP2(UV,HYS)</sub>	V <sub>VCP2(UV,H)</sub> - V <sub>VCP2(UV,L)</sub>	-	1.2	_	V
BG1 and BG2 Undervoltage Thresholds <sup>[2]</sup>	V <sub>BGx(UV)</sub>	$V_{BG1}$ or $V_{BG2}$ falling	1.00	1.05	1.10	V
OVERVOLTAGE FILTERING/DEGL	ТСН ТІМЕ					
Overvoltage Detection Delay <sup>[2]</sup>	t <sub>d(OV)</sub>	Overvoltage detection delay time	5	_	25	μs
UNDERVOLTAGE FILTERING/DEG	LITCH TIME					
Undervoltage Filter/Deglitch Times [2]	t <sub>d(UV)</sub>	Undervoltage detection delay time	5	_	25	μs

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<sup>[2]</sup> Ensured by design and characterization, not production tested.

<sup>[3]</sup> Specifications at 25°C or 85°C are guaranteed by design and characterization, not production tested.



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

## ELECTRICAL CHARACTERISTICS (continued) <sup>[1]</sup>: Valid at 3.8 V <sup>[4]</sup> $\leq$ V<sub>VIN</sub> $\leq$ 36 V, -40°C $\leq$ T<sub>J</sub> $\leq$ 150°C, V<sub>ENB</sub> = High or V<sub>ENBAT</sub> = High, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
NPOR TURN-ON AND TURN-OFF	DELAYS	•	·			
NPOR Turn-on Delay	t <sub>d(NPOR,ON)</sub>	Time from when VUC and V5C are all in regulation to NPOR being asserted high	15	20	25	ms
NPOR OUTPUT VOLTAGES		•				
NPOR Output Low Voltage	V <sub>NPOR(L)</sub>	V <sub>VIN</sub> ≥ 2.5 V, I <sub>NPOR</sub> = 2 mA	_	150	400	mV
NPOR Leakage Current <sup>[1]</sup>	I <sub>NPOR(LKG)</sub>	V <sub>NPOR</sub> = 3.3 V	-	-	2	μA
NPOR ONE-SHOT TIME	· · ·	·	,	^ 		
NPOR One-Shot Low Time After Watchdog Fault	t <sub>WD(FAULT)</sub>		1.6	2	2.4	ms
FAULT FLAG OUTPUT VOLTAGE	S (FFn)					
FFn Output Voltage	V <sub>FF(L)</sub>	FFn is tripped, V <sub>VIN</sub> ≥ 2.5 V, I <sub>FF</sub> = 2 mA	-	150	400	mV
FFn Leakage Current	I <sub>FF(LKG)</sub>	V <sub>FF</sub> = 3.3 V	-	-	2	μA
WDIN VOLTAGE THRESHOLDS A	ND CURRENT					
MD Input Voltage Threeholds	V <sub>WDIN(LO)</sub>	V <sub>WDIN</sub> falling	0.8	-	-	V
WD <sub>IN</sub> Input Voltage Thresholds	V <sub>WDIN(HI)</sub>	V <sub>WDIN</sub> rising	-	-	2.0	V
WD <sub>IN</sub> Pull-Down Resistance <sup>[2]</sup>	R <sub>WDIN</sub>		-	50	-	kΩ
WD <sub>IN</sub> TIMING SPECIFICATIONS						
WD <sub>IN</sub> Duty Cycle [2]	D <sub>WDIN</sub>		-	50	-	%
Watchdog Activation Delay	t <sub>d(WD)</sub>		-	30	_	ms
GATE DRIVE ENABLE (POE)						
	V <sub>POE(L)</sub>	I <sub>POE</sub> = 4 mA	-	150	400	mV
POE Output Voltage	V <sub>POE(H)</sub>	I <sub>POE</sub> = -1.5 mA	0.8 × V <sub>VUC</sub>	-	_	V
VUCSEL LOGIC INPUT						
VUCSEL Thresholds	V <sub>VUCSEL(H)</sub>	V <sub>VUCSEL</sub> rising	-	-	2.0	V
	V <sub>VUCSEL(L)</sub>	V <sub>VUCSEL</sub> falling	0.8	_	_	V

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<sup>[2]</sup> Ensured by design and characterization, not production tested.

<sup>[3]</sup> Specifications at 25°C or 85°C are guaranteed by design and characterization, not production tested.



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

## ELECTRICAL CHARACTERISTICS (continued) <sup>[1]</sup>: Valid at 3.8 V <sup>[4]</sup> $\leq$ V<sub>VIN</sub> $\leq$ 36 V, -40°C $\leq$ T<sub>J</sub> $\leq$ 150°C, V<sub>ENB</sub> = High or V<sub>ENBAT</sub> = High, unless otherwise specified

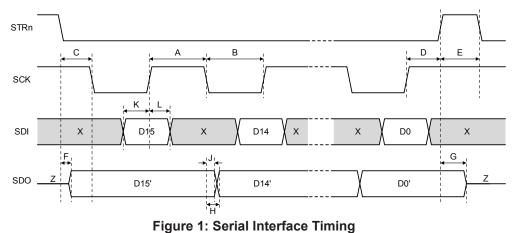
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
SERIAL INTERFACE (STRn, SDI, SD	O, SCK)		·			
Input Low Voltage	V <sub>IL</sub>		-	_	0.8	V
Input High Voltage	V <sub>IH</sub>	All logic inputs	2.0	_	-	V
Input Hysteresis	V <sub>lhys</sub>	All logic inputs	250	550	-	mV
Input Pull-Down SDI, SCK	R <sub>PDS</sub>	0 V < V <sub>VIN</sub> < 5 V	-	50	-	kΩ
Input Pull-Up To VCC	I <sub>PU</sub>	STRn	-	50	-	kΩ
Output Low Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 1 mA <sup>[1]</sup>	-	_	0.4	V
Output High Voltage	V <sub>OH</sub>	$I_{OL} = -1 \text{ mA}^{[1]}$	0.8 × V <sub>VUC</sub>	_	_	V
Clock High Time	t <sub>SCKH</sub>	A in Figure 1	50	-	-	ns
Clock Low Time	t <sub>SCKL</sub>	B in Figure 1	50	-	-	ns
Strobe Lead Time	t <sub>STLD</sub>	C in Figure 1	30	-	-	ns
Strobe Lag Time	t <sub>STLG</sub>	D in Figure 1	30	_	-	ns
Strobe High Time	t <sub>STRH</sub>	E in Figure 1	300	_	-	ns
Data Out Enable Time	t <sub>SDOE</sub>	F in Figure 1	_	_	40	ns
Data Out Disable Time	t <sub>SDOD</sub>	G in Figure 1	_	_	30	ns
Data Out Valid Time From Clock Falling	t <sub>SDOV</sub>	H in Figure 1	-	_	40	ns
Data Out Hold Time From Clock Falling	t <sub>SDOH</sub>	J in Figure 1	5	_	-	ns
Data In Setup Time To Clock Rising	t <sub>sDIS</sub>	K in Figure 1	15	_	_	ns
Data In Hold Time From Clock Rising	t <sub>SDIH</sub>	L in Figure 1	10	_	_	ns
Wake Up From Sleep	t <sub>EN</sub>		-	_	2	ms

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<sup>[2]</sup> Ensured by design and characterization, not production tested.

<sup>[3]</sup> Specifications at 25°C or 85°C are guaranteed by design and characterization, not production tested.

<sup>[4]</sup> The lowest operating voltage is only valid if the conditions  $V_{VIN} > V_{VIN(START)}$  and  $V_{VCP} - V_{VIN} > V_{VCP(UV,H)}$  and  $V_{VREG}$  in regulating are satisfied before  $V_{VIN}$  is reduced.



X = do not exceed Watchdog Configuration timeout; Z = high-impedance (tri-state)



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

## ELECTRICAL CHARACTERISTICS (continued) <sup>[1]</sup>: Valid at 3.8 V <sup>[4]</sup> ≤ V<sub>VIN</sub> ≤ 36 V, −40°C ≤ T<sub>J</sub> ≤ 150°C, V<sub>ENB</sub> = High or V<sub>ENBAT</sub> = High, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Gate Output Drive	·		•			
Turn-On Time	t <sub>r</sub>	C <sub>LOAD</sub> = 10 nF, 20% to 80%	_	5	_	μs
Turn-Off Time	t <sub>f</sub>	C <sub>LOAD</sub> = 10 nF, 80% to 20%	-	0.5	-	μs
Turn-On Pulse Current	I <sub>GXP</sub>		8.5	10	12	mA
Turn-On Pulse Time	t <sub>GXP</sub>		22	-	42	μs
On Hold Current	I <sub>GXH</sub>		-	400	-	μA
Pull-Down On Resistance	Б	T <sub>J</sub> = 25°C, I <sub>Gx</sub> = 10 mA	-	5	-	Ω
Full-Down On Resistance	R <sub>DS(on)DN</sub>	T <sub>J</sub> = 150°C, I <sub>Gx</sub> = 10 mA	-	10	-	Ω
		$V_{VIN}$ > 5.5 V (w.r.t. Sx, or VIN if $V_{Sx}$ > $V_{VIN}$ )	8	9	12	V
Gx Output High Voltage	V <sub>GH</sub>	5.0 V < V <sub>VIN</sub> $\leq$ 5.5 V (w.r.t. Sx, or VIN if V <sub>Sx</sub> > V <sub>VIN</sub> ), Buck-boost mode	7.2	9	_	V
		$V_{VIN}$ = 4.5 V, $V_{SX}$ = 5.5 V (w.r.t. Sx), Buck-boost mode	6.2	6.9	-	V
Gate Drive Static Load Resistance [2]	R <sub>GS</sub>	Between Gx and Sx (using ±1% tolerance resistor)	100	_	-	kΩ
Gx Output Voltage Low	V <sub>GL</sub>	–10 μA < I <sub>Gx</sub> < 10 μA	-	-	V <sub>Sx</sub> + 0.3	V
Gx Passive Pull-Down	R <sub>GPD</sub>	$V_{Gx} - V_{Sx} < 0.3 V$	-	950	-	kΩ
SVBB Undervoltage Threshold Falling	V <sub>SVBB(UV,L)</sub>	V <sub>SVBB</sub> falling (w.r.t. GND)	-	-	3	V
SVBB Undervoltage Filter/Deglitch		Undervoltage detection delay time, slow; GD_UV_FLT = 0	_	0.8	1.0	ms
Times	t <sub>d(UV,FILT,BB)</sub>	Undervoltage detection delay time, fast; GD_UV_FLT = 1	3.7	-	18	μs
SU Undervoltage Threshold Falling	V <sub>SUUV(L)</sub>	V <sub>SU</sub> falling (w.r.t. GND); GD_U_SEL = 1	-	-	3	V
SIII Indonyaltago Filtor/Doglitak Timoo		Undervoltage detection delay time, slow; GD_UV_FLT = 0, GD_U_SEL = 1	_	0.8	1.0	ms
SU Undervoltage Filter/Deglitch Times	t <sub>d(UV,FILT,SU)</sub>	Undervoltage detection delay time, fast; GD_UV_FLT = 1	3.7	_	18	μs
GSx Undervoltage Threshold Rising [2]	V <sub>GSx(UV,H)</sub>	V <sub>Gx</sub> rising (w.r.t. Sx, x = VBB, U, V, W)	6.0	-	7.0	V
GSx Undervoltage Threshold Hysteresis <sup>[2]</sup>	V <sub>GSx(UV,HYS)</sub>	x = VBB, U, V, W	_	250	_	mV
GSx Undervoltage Filter/Deglitch Time	t <sub>d(UV,FILT,GSx)</sub>	Undervoltage detection delay time, x = VBB, U, V, W	-	1.4	_	ms

<sup>[1]</sup> For input and output current specifications, negative current is defined as coming out of the node or pin (sourcing), positive current is defined as going into the node or pin (sinking).

<sup>[2]</sup> Ensured by design and characterization, not production tested.

<sup>[3]</sup> Specifications at 25°C or 85°C are guaranteed by design and characterization, not production tested.



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

## ELECTRICAL CHARACTERISTICS (continued) <sup>[1]</sup>: Valid at 3.8 V <sup>[4]</sup> $\leq$ V<sub>VIN</sub> $\leq$ 36 V, -40°C $\leq$ T<sub>J</sub> $\leq$ 150°C, V<sub>ENB</sub> = High or V<sub>ENBAT</sub> = High, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
GATE OUTPUT DRIVE (continued)						
ENVBB Enable/Disable Delay Time	t <sub>d(EN,BB)</sub>	From SPI command is written to GVBB 20% (enable), to GVBB 80% (disable); GD_EN_DLY = 0	-	1.5	_	ms
ENUL Enchle/Dischle Dolou/Time		From SPI command is written to GU 20% (enable), to GU 80% (disable); GD_U_SEL = 1; GD_EN_DLY = 0	_	1.5	_	ms
ENU Enable/Disable Delay Time	<sup>t</sup> d(EN,U)	From SPI command is written to GU 20% (enable), to GU 80% (disable); GD_U_SEL = 0; GD_EN_DLY = 0	_	10	_	ms
ENV and ENW Enable/Disable Delay Time	t <sub>d(EN,X)</sub>	From SPI command is written to Gx 20% (enable), to Gx 80% (disable); GD_EN_DLY = 0	_	10	_	ms
ENVBB, ENU, ENV, and ENW Enable Delay Time, Fast	t <sub>d(EN,X)</sub>	From SPI command is written to Gx 20%; GD_EN_DLY = 1	-	_	3	μs
ENVBB, ENU, ENV, and ENW Disable Delay Time, Fast	t <sub>d(EN,X)</sub>	From SPI command is written to Gx 80%; GD_EN_DLY = 1	_	_	2.25	μs

<sup>[1]</sup> For input and output current specifications, negative current is defined as coming out of the node or pin (sourcing), positive current is defined as going into the node or pin (sinking).

<sup>[2]</sup> Ensured by design and characterization, not production tested.

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## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

		-	or/Isolator C FF, 1 = ON, R					AR	G82801 Statu	ıs Signals			]
ARG82801 MODE	VREG ON	VUC ON	V5C ON	V5P1 and V5P2 ON	lsolator Drivers	EN	MPOR	VREG UV	vuc uv	V5C UV	V5P1 and V5P2 UV	NPOR	
RESET	0	0	0	0	0	0	1	0	0	0	0	0	1
OFF	0	0	0	0	0	0	0	1	1	1	1	0	1
STARTUP	1	0	0	0	0	1	0	1	1	1	1	0	
$\downarrow$	1	1	0	0	R	1	0	0	1	1	1	0	
$\downarrow$	1	1	1	0	R	1	0	0	0	1	1	1	
$\downarrow$	1	1	1	R	R	1	0	0	0	0	1	1	
RUN	1	1	1	R	R	1	0	0	0	0	0	1	1
15 μs DEGLITCH	1	1	1	R	R	0	0	0	0	0	0	0	1
SHUTTING DOWN	1	1	0	0	R	0	0	0	0	0	0	0	
$\downarrow$	1	0	0	0	0	0	0	0	0	1	1	0	
$\downarrow$	0	0	0	0	0	0	0	0	1	1	1	0	
OFF	0	0	0	0	0	0	0	1	1	1	1	0	1

#### Table 1: Startup and Shutdown Logic (signal names consistent with Block Diagram)

 $\mathbf{X} = \mathbf{n}/\mathbf{a}$ 

 $\mathbf{EN} = \mathbf{ENBAT} + \mathbf{ENB}$ 

 $\mathbf{MPOR} = \mathrm{VCC}_{\mathrm{UV}} + \mathrm{VCPx}_{\mathrm{UV}} + \mathrm{BG1}_{\mathrm{UV}} + \mathrm{BG2}_{\mathrm{UV}} + \mathrm{TSD} + \mathrm{D1}_{\mathrm{MISSING}} (\mathrm{latched}) + \mathrm{I}_{\mathrm{LIM}(\mathrm{LX})} (\mathrm{latched})$ 



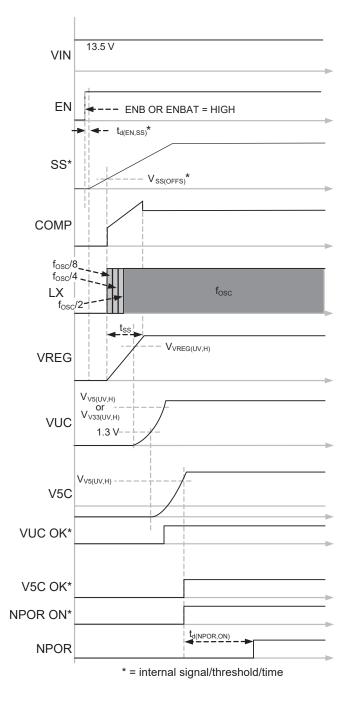
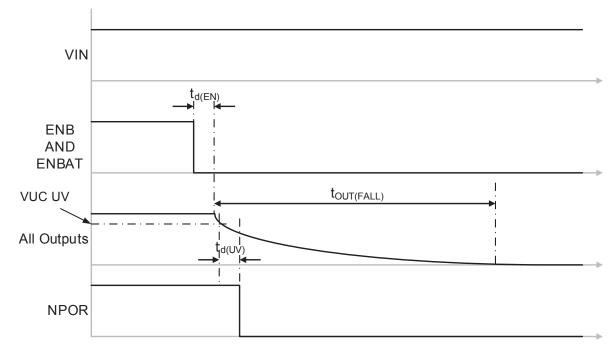


Figure 2: Startup Timing Diagram





All outputs start to decay  $t_{d(EN)}$  seconds after ENB and ENBAT are low.

Time for outputs to drop to zero,  $t_{OUT(FALL)}$ , various for each output and depends on load current and capacitance. NPOR falls when VUC reaches its UV point.

#### Figure 3: Shutdown Timing Diagram



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

TIMING DIAGRAMS (not to scale)

\* = internal signal/threshold, + is for "or"

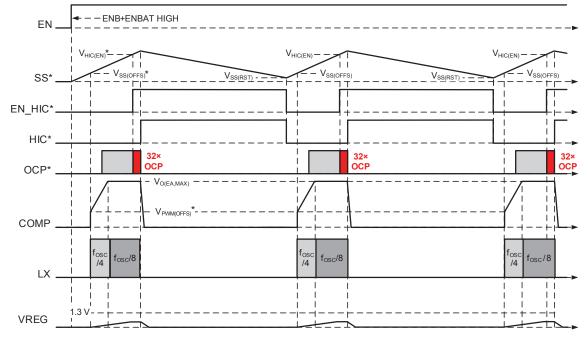


Figure 4: Hiccup Mode Operation with VREG Shorted to GND ( $R_{LOAD}$  < 50 m $\Omega$ )

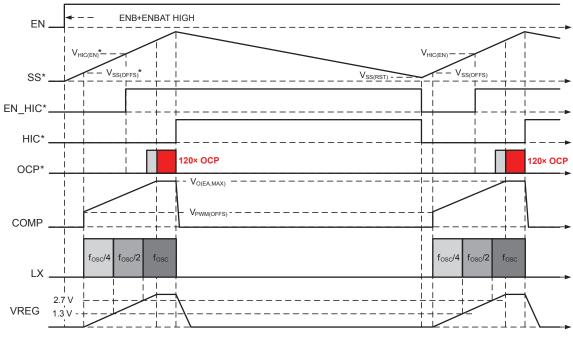


Figure 5: Hiccup Mode Operation with VREG Overloaded ( $R_{LOAD} \approx 0.5 \Omega$ )



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

#### Table 2: Summary of Fault Mode Operation

FAULT TYPE and CONDITION	ARG82801 RESPONSE TO FAULT	LATCHED FAULT?	vcc	VCP1	VCP2	VREG	vuc	V5C	V5P1	V5P2	Isolator Drivers	NPOR	FFn	POE	SPI	WD	RESET METHOD
VREG asynchronous diode (D1) missing	Results in an MPOR after 1 detection, so all regulators are shut off	Yes	No effect	No effect	No effect	Off	Off	Off	Off	Off	Off	Low	Low	Low	Off	Off	Place D1 then cycle EN or VIN
Asynchronous diode (D1) short-circuited or LX shorted to ground	Results in an MPOR after the high-side MOSFET current exceeds I <sub>LIM(LX)</sub> so all regulators are shut off	Yes	No effect	No effect	No effect	Off	Off	Off	Off	Off	Off	Low	Low	Low	Off	Off	Remove the short then cycle EN or VIN
VCP1 OV	If OV condition persists for more than t <sub>d(OV)</sub> , then set FFn Low	No	No effect	> V <sub>VCP1(OV,H)</sub>	No effect	No effect	No effect	No effect	No effect	No effect	No effect	No effect	Low	No effect	On	On	Check for short circuits on VCP1
VIN UVLO	ARG82801 is in reset state	No	Ramping	VIN	VIN	Off	Off	Off	Off	Off	Off	Low	Low	Low	Off	Off	Increase VIN
BG1 UVLO	ARG82801 is in reset state	No	Ramping	VIN	VIN	Off	Off	Off	Off	Off	Off	Low	Low	Low	Off	Off	Replace ARG82801
BG2 UVLO	ARG82801 is in reset state	No	Ramping	VIN	VIN	Off	Off	Off	Off	Off	Off	Low	Low	Low	Off	Off	Replace ARG82801
VCC UVLO	ARG82801 is in reset state	No	UVLO	VIN	VIN	Off	Off	Off	Off	Off	Off	Low	Low	Low	Off	Off	Remove the short circuit
VCC short limit	ARG82801 is in reset state	No	UVLO	VIN	VIN	Off	Off	Off	Off	Off	Off	Low	Low	Low	Off	Off	Remove the short circuit
VCP1 UVLO	ARG82801 is in	No	ON	UVLO	No effect	Off	Off	Off	Off	Off	Off	Low	Low	Low	Off	Off	Remove the
VCP2 UVLO	Cutputs remain on, Isolator Drivers turn off.	No	ON	No effect	UVLO	No effect	No effect	No effect	No effect	No effect	Off	No effect	Low	Low	No effect	No effect	short circuit Remove the short circuit
VREG overvoltage V <sub>VREG(OV,H)</sub> < V <sub>VREG</sub>	Stop PWM switching of LX	No	No effect	No effect	No effect	> V <sub>VREG(OV,H)</sub>	No effect	No effect	No effect	No effect	No effect	No effect	Low	No effect	No effect	No effect	Check for short circuits on VREG
VREG pin open circuit	VREG decays to 0 V, LX switches at maximum duty cycle so the voltage on the output capacitors are very close to VBAT	No	No effect	No effect	No effect	Decay to 0 V	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Low if VUC < V <sub>VXX(UV,L)</sub>	Low	Off if V <sub>VREG</sub> < UVLO	No effect	No effect	Connect the VREG pin
VREG shorted to ground V <sub>VREG</sub> < 1.3 V, V <sub>COMP</sub> $\neq$ V <sub>O(EA,MAX)</sub>	Continue to PWM but turn off LX when the high side MOSFET current exceeds	No	No effect	No effect	No effect	Shorted	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Low if VUC < V <sub>VXX(UV,L)</sub>	Low	Off if V <sub>VREG</sub> < UVLO	No effect	No effect	Remove the short circuit
VREG overcurrent V <sub>VREG</sub> < 1.3 V, V <sub>COMP</sub> = V <sub>O(EA,MAX)</sub>	Enters hiccup mode after 32 OCP faults	No	No effect	No effect	No effect	Over- current	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Low if VUC < V <sub>VXX(UV,L)</sub>	Low	Off if V <sub>VREG</sub> < UVLO	No effect	No effect	Decrease the load
VREG overcurrent V <sub>VREG</sub> > 1.3 V, V <sub>COMP</sub> = V <sub>O(EA,MAX)</sub>	Enters hiccup mode after 120 OCP faults	No	No effect	No effect	No effect	Over- current	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Off if V <sub>VREG</sub> < UVLO	Low if VUC < V <sub>VXX(UV,L)</sub>	Low	Low if VUC < V <sub>VXX(UV,L)</sub>	No effect	No effect	Decrease the load
VUC undervoltage	Closed loop control tries to raise the voltage but may be constrained by the foldback or pulse-by-pulse current limit	No	No effect	No effect	No effect	No effect	V <sub>VUC</sub> < V <sub>VXX(UV,L)</sub>	No effect	No effect (Track to VUC)	No effect (Track to VUC)	Off	Low	Low	Low	No effect	No effect	Decrease the load
VUC overvoltage	If OV condition persists for more than t <sub>d(OV)</sub> then set NPOR Low	No	No effect	No effect	No effect	No effect	V <sub>VUC</sub> > V <sub>VXX(OV,H)</sub>	No effect	No effect (Track to VUC)	No effect (Track to VUC)	Off	Low	Low	Low	No effect	No effect	Check for short circuits
VUC overcurrent	Foldback current limit reduces the output voltage	No	No effect	No effect	No effect	No effect	Falling	No effect	No effect (Track to VUC)	No effect (Track to VUC)			Low if VUC < V <sub>VXX(UV,L)</sub>		No effect	No effect	Decrease the load
V5P1 undervoltage	Closed loop control tries to raise the voltage but may be constrained by the foldback current limit	No	No effect	No effect	No effect	No effect	No effect	No effect	V <sub>V5P1</sub> < V <sub>V5(UV,L)</sub>	No effect	No effect	No effect	Low	No effect	No effect	No effect	Decrease the load
V5P1 overvoltage or shorted to VBAT	If OV condition persists for more than t <sub>d(OV)</sub> then set FFn Low	No	No effect	No effect	No effect	No effect	No effect	No effect	Off	No effect	No effect	No effect	Low	No effect	No effect	No effect	Check for short circuits on V5P1

Continued on next page ...



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

#### Table 2: Summary of Fault Mode Operation (continued)

FAULT TYPE and	ARG82801 RESPONSE	LATCHED	vcc	VCP1	VCP2	VREG	vuc	V5C	V5P1	V5P2	Isolator	NPOR	FFn	POE	SPI	WD	RESET
CONDITION	TO FAULT	FAULT?	100	VOFI	VOF2		100	*50	VOFI	V 0F 2	Drivers	NF OK		FUL	551		METHOD
V5P1 overcurrent	Foldback current limit reduces the output voltage	No	No effect	Falling	No effect	No effect	No effect	Low	No effect	No effect	No effect	Decrease the load					
V5P2 undervoltage	Closed loop control tries to raise the voltage but may be constrained by the foldback current limit	No	No effect	No effect	V <sub>V5P2</sub> < V <sub>V5(UV,L)</sub>	No effect	No effect	Low	No effect	No effect	No effect	Decrease the load					
V5P2 overvoltage or shorted to VBAT	If OV condition persists for more than t <sub>d(OV)</sub> then set FFn Low	No	No effect	No effect	Off	No effect	No effect	Low	No effect	No effect	No effect	Check for short circuits on V5P2					
V5P2 overcurrent	Foldback current limit reduces the output voltage	No	No effect	No effect	Falling	No effect	No effect	Low	No effect	No effect	No effect	Decrease the load					
V5C overvoltage	If OV condition persists for more than t <sub>d(OV)</sub> then set FFn Low	No	No effect	V <sub>V5C</sub> > V <sub>V5(OV,H)</sub>	No effect	No effect	No effect	No effect	Low	No effect	No effect	No effect	Check for short circuits on V5C				
V5C undervoltage	Closed loop control tries to raise the voltage but may be constrained by the foldback current limit	No	No effect	V <sub>V5C</sub> < V <sub>V5(UV,L)</sub>	No effect	No effect	No effect	No effect	Low	No effect	No effect	No effect	Decrease the load				
V5C overcurrent	Foldback current limit reduces the output voltage	No	No effect	Falling	No effect	No effect	No effect	No effect	Low	No effect	No effect	No effect	Decrease the load				
Thermal shutdown	Results in an MPOR, so all regulators are shut off	No	No effect	No effect	No effect	Off	Off	Off	Off	Off	Off	Low	Low	Low	No effect	No effect	Let the ARG82801 cool
Window WD error	Put the system into a safe state	No	No effect	Off	Off	Off	Low (One shot)	Low	Low	No effect	-	Get proper signal from microcontroller					
Q&A watchdog error	Put the system into a safe state	No	No effect	Off	Off	Off	Low (One shot)	Low	Low	No effect	-	Get proper signal from microcontroller					
BIST error	Fault flag	No	No effect	No effect	No effect	Off	No effect	Low	Low	No effect	No effect	Write 1 to reset					
SVBB_UV	Corresponding (GVBB) Isolator off	Yes	No effect	No effect	No effect	GVBB: off GU, GV, GW: No effect	No effect	Low	No effect	No effect	No effect	Check for short circuits on SVBB, Toggle ENVBB					
SU_UV (see 0x09 [D7])	Corresponding (GU) Isolator off	Yes	No effect	No effect	No effect	GU: off GVBB, GV, GW: No effect	No effect	Low	No effect	No effect	No effect	Check for short circuits on SU, Toggle ENU and Write 1 to reset					
GSx_UV	Fault flag	No	No effect	No effect	No effect	No effect	No effect	Low	No effect	No effect	No effect	Check for short circuits on Gx					
LG operation failure	Fault flag	No	No effect	No effect	No effect	No effect	No effect	Low	No effect	No effect	No effect	Check for short circuits on LG					
VDD_UV	Fault flag	No	No effect	No effect	No effect	No effect	No effect	Low	No effect	May lose contents	May have effect	Restart the device					
DBE Fault	Fault flag	No	No effect	No effect	No effect	No effect	No effect	Low	No effect	No effect	No effect	Restart the device					
SE Fault	Fault flag	No	No effect	No effect	No effect	No effect	No effect	Low	No effect	No effect	No effect	Check SPI signal					



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

## FUNCTIONAL DESCRIPTION

### Overview

The ARG82801 is a power management IC designed for safetycritical applications. It contains one switching and four linear regulators to create the voltages necessary for typical automotive applications such as electrical power steering.

The ARG82801 pre-regulator can be configured as a buck converter or buck boost. Buck boost is suitable for when applications must work with extremely low battery voltages. This pre-regulator generates a fixed 5.35 V to power the internal or external post-regulators. These post-regulators generate the various voltage levels for the end system.

### **Pre-Regulator**

The pre-regulator incorporates an internal high-side buck switch and a boost switch gate driver. An external freewheeling diode and LC filter are required to complete the buck converter. By adding a MOSFET and boost diode, the pre-regulator can now maintain all outputs with input voltages down to 3.8 V.

The pre-regulator provides many protection and diagnostic functions:

- 1. Pulse-by-pulse and hiccup mode current limit
- 2. Undervoltage detection and reporting
- 3. Shorted switch node to ground
- 4. Open freewheeling diode protection
- 5. High voltage rating for load dump

## **Bias Supply**

The bias supply  $(V_{CC})$  is generated by an internal linear regulator. This supply is the first rail to start up. Most of the internal control circuitry is powered by this supply. The bias supply includes some unique features to ensure safe operation of the ARG82801. These features include:

- 1. Input voltage undervoltage lockout
- 2. Output undervoltage detection and reporting
- 3. Overcurrent and short-circuit limit
- 4. Dual input, VIN and VREG, for low battery voltage operation

#### **Charge Pump**

Charge pump circuits provide the voltage necessary to drive highside N-channel MOSFETs in the pre-regulator, linear regulators, and floating gate drivers. Four external capacitors are required for charge pump operation. During the first cycle of the charge pump action, the flying capacitor between pins CP1C1 and CP1C2 is charged either from VIN or VREG, whichever is highest. During the second cycle, the voltage on the flying capacitor charges the VCP1 capacitor and the flying capacitor, between pins CP2C1 and CP2C2. During the next cycle, the voltage on the flying capacitor charges the VCP2 capacitor. The charge pump incorporates some safety features:

- 1. Undervoltage and overvoltage detection and reporting
- 2. Overcurrent safe mode protection

### Bandgap

Dual bandgaps are implemented within the ARG82801. One bandgap is dedicated to the voltage regulation loops within each of the regulators, VCC, VCPx, VREG, and the four postregulators. The second is dedicated to the monitoring function of all the regulators undervoltage and overvoltage. This improves safety coverage and fault reporting from the ARG82801.

Should the regulation bandgap fail, then the outputs are out of specification and the monitoring bandgap reports the fault.

If the monitoring bandgap fails, the outputs remain in regulation, but the monitoring circuits report the outputs as out of specification and trip the fault flag.

The bandgap circuits include two other bandgaps that are used to monitor the undervoltage state of the main bandgaps.

#### Enable

Two enable pins are available on the ARG82801. A high signal on either of these pins enables the regulated outputs of the ARG82801. One enable (ENB) is logic-level compatible. The second enable (ENBAT), is battery-level rated and can be connected to the ignition switch.

## Linear Regulators

The ARG82801 has four linear regulators: one 5 V regulator, one 5 V or 3.3 V selectable regulator, and two protected regulators which track VUC (5 V or 3.3 V).

All linear regulators provide the following protection features:

- 1. Current limit with foldback
- 2. Undervoltage and overvoltage detection and reporting

The protected regulators (V5P1 and V5P2) include protection against connection to the battery voltage. This makes these outputs suitable for powering remote sensors or circuitry where short to battery is possible.



The pre-regulator powers these linear regulators which reduces power dissipation and temperature.

	VUCSEL	V <sub>OUT(TYP)</sub>	Startup	Tracking
VUC	1	5 V	When	n/a
VUC	0	3.3 V	$V_{VREG} > V_{VREG(UV,H)}$	n/a
V5C	n/a	5 V	When V <sub>VUC</sub> > V <sub>V5</sub> / V <sub>V33(UV,H)</sub>	n/a
V5Px	n/a	5 V	Enabled via SPI	VUC (DC level) During start-up it does not track VUC since default SPI bit is disabled

## Fault Detection and Reporting

There is extensive fault detection within the ARG82801; most have been discussed previously. There are two fault reporting mechanisms used by the ARG82801: one through hardwired pins and the other through a serial communications interface (SPI).

Two hardwired pins on the ARG82801 are used for fault reporting. The first pin, NPOR, reports on the status of the VUC output. This signal goes low if this output is out of regulation. The second pin, FFn (active low fault flag), reports on all other faults. FFn goes low if a fault within the ARG82801 exists. The FFn pin can be used by the processor as an alert to check the status of the ARG82801 via SPI and see where the fault occurred.

## Startup Self-Test

The ARG82801 includes self-test which is performed during the startup sequence. This self-test verifies the operation of the undervoltage and overvoltage detection circuits for the main outputs.

In the event the self-test fails, the ARG82801 reports the failure through SPI.

## **Undervoltage Detect Self-Test**

The undervoltage (UV) detectors are verified during startup of the ARG82801. A voltage that is higher than the undervoltage threshold is applied to each UV comparator; this should cause the relative undervoltage fault bit in the diagnostic registers to change state. If the diagnostic UV register bits change state, the corresponding verify register bits latches high. When the test of all UV detectors is complete, the verify register bits remains high if the test passed. If any UV bits in the verify registers, after test, are not set high, then the verification has failed. The following UV detectors are tested: VREG, VUC, V5C, V5P1, and V5P2.

### **Overvoltage Detect Self-Test**

The overvoltage (OV) detectors are verified during startup of the ARG82801. A voltage is applied to each OV comparator that is higher than the overvoltage threshold; this should cause the relative overvoltage fault bit in the diagnostic registers to change state. If the diagnostic OV register bits change state, the corresponding verify register bits latches high. When the test of all OV detectors is complete, the verify register bits remains high if the test passed. If any OV bits in the verify registers after test are not set high, then the verification has failed. The following OV detectors are tested: VREG, VUC, V5C, V5P1, and V5P2.

## **Overtemperature Shutdown Self-Test**

The overtemperature shutdown (TSD) detector is verified on startup of the ARG82801. A voltage is applied to the comparator that is lower than the overtemperature threshold and should cause the general fault flag to be active and an overtemperature fault bit, TSD, to be latched in the Verify Result register 0. When the test is complete, the general fault flag is cleared and the overtemperature fault remains in the Verify Result register 0 until reset. If the TSD bit is not set, then the verification has failed.

## Power-On Enable Self-Test

The ARG82801 also incorporates continuous self-testing of the power-on enable (POE) output. It compares the status of the POE pin with the internal demanded status. If they differ for any reason, an FFn is set and the POE\_OK in SPI diagnostic register goes low.

## Watchdog Timer

The ARG82801 has two watchdog functions: window watchdog timer and Q&A watchdog timer. When the regulators (VUC and V5C) have been above their undervoltage thresholds for watchdog activation delay ( $t_{d(WD)}$ ), WD is activated, WD state is in the configuration state, and the user can set the configuration within 220 ms (min,  $t_{WDTO(CONFIG)}$ ). If no configuration input until  $t_{WDTO(CONFIG)}$  is expired, WD moves into reset. Moving back to configuration mode requires secure SPI command (0x0B).

#### WINDOW WATCHDOG

The ARG82801 window watchdog circuit monitors an external clock applied to the WDIN pin. This clock should be generated by the microcontroller or DSP. The time between rising edges of the clock must fall within a SPI-programmed window or a watchdog fault is generated. A watchdog fault is set NPOR and POE low.

After startup, if no clock edges are detected at WDIN for watchdog activation delay  $t_{d(WD)}$  + maximum timeout (written in 0x09), the ARG82801 generates a watchdog fault and reset its counters. This process repeats until the system recovers and clock edges are applied to WDIN.



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

#### **Q&A WATCHDOG**

The Q&A watchdog circuit monitors an answer code from the microcontroller. The Q&A watchdog procedure is as follows:

- 1. Write 0x08 to set open window period and acceptable number of mis-refresh in configuration mode.
- 2. Write 0x0B for watchdog restart. Then ARG82801 enters into normal mode and generates 6-bit random code.
- 3. Microcontroller reads 0x0A to get 6-bit random code via SDO.
- 4. Write 0x0A with 6-bit inverted random code within open window period. In case the ARG82801 cannot get the right inverted code, then the watchdog timer is refreshed and generates new 6-bit random code. ARG82801 can accept mis-refresh.
- 5. Repeat #2 to #4 within the programmed window.

#### **Analog Multiplexer Output**

The AMUXO terminal is an analog multiplexer output to monitor the voltage of the nodes detailed in Table 3. The output is selected through the serial interface (0x0C). The driving capability of this output is 1 mA and maximum voltage is 3.8 V. Reference response time from SPI register write to AMUX output change is  $\sim 20 \ \mu s$ .

Node	Signal Divide Ratio	Tolerance (reference)
VREG	1/2	±6%
VUC	1/2	±6%
V5C	1/2	±6%
V5P1	1/2	±6%
V5P2	1/2	±6%
VENBAT	1/8	±6%
VCP1	1/12	±6%
VCP2	1/12	±6%
BG1	1/1	±6%
BG2	1/1	±6%
VIN	1/10	±6%
TEMP	-	Output (mV) = 1440 mV - 3.92 mV/°C × T <sub>J</sub> (°C)

#### Table 3: Analog Multiplexer Output

#### **Floating MOSFET Gate Drivers**

The ARG82801 has four independent floating gate drive outputs to drive external, low on-resistance, power N-channel MOSFETs connected as a 3-phase solid state relay in phase-isolation applications and an input battery line isolator.

A charge pump regulator provides the above-battery supply voltage necessary to maintain the power MOSFETs in the on state continuously when the phase voltage is equal to the battery voltage.

An internal resistor,  $R_{GPD}$ , between the Gx and Sx pins plus an integrated hold-off circuit, ensures that the gate-source voltage of the MOSFET is held close to 0 V even with the power disconnected. This can remove the need for additional gate-source resistors on the isolation MOSFETs. In any case, if gate-source resistors are mandatory for the application, then the pump regulator can provide sufficient current to maintain the MOSFET in the on state with a gate-source resistor as low as 100 k $\Omega$ .

The four gate drives can be controlled independently through the serial interface by setting the appropriate bit in the control register.

The floating gate-drive outputs for external N-channel MOSFETs are provided on pins GVBB, GU, GV, and GW. Gx = 1 (or high) means that the upper half of the driver is turned on and current is sourced to the gate of the MOSFET in the phase isolation circuit, turning it on. Gx = 0 (or low) means that the lower half of the driver is turned on and sinks current from the external MOSFET's gate to the respective Sx terminal, turning it off.

The reference points for the floating drives are the load phase connections, SVBB, SU, SV, and SW. The discharge current from the floating MOSFET gate capacitance flows through these connections.

In some applications, it may be necessary to provide a current recirculation path when the motor load is isolated. This is necessary in situations where the motor driver does not reduce the load current to zero before the isolation MOSFETs are turned off.

The recirculation path can be provided by connecting a suitably rated power diode to the motor side of the isolation MOSFETs and GND. See the Functional Block Diagram for more details.



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

#### Table 4: Floating MOSFET Driver

Name	GD_U_SEL	Purpose		Enable/Disable		Gate to Source UV	Source to	GND UV		UV Filter					
Name	(0x09 [D5])	Pulpose	Register Bit	GD_EN_DLY	Delay	State Register bit	Function	State Register bit	GD_UV_FLT	GSx UV Filter	SVBB/SU UV Filter				
GVBB /		VBAT	ENVBB	0	1.5 ms	GSVBB_UV		SVBB_UV	0	1.4 ms	0.8 ms				
SVBB	X (don't care)	disconnect	(0x07 [D3])	1	EN < 3 μs DIS < 2.25 μs	(0x02 [D7])	Yes	(0x02 [D3])	1	11 µs	11 µs				
		Phase		0	10 ms			SU_UV	0	1.4 ms	-				
GU / SU	0	disconnect	ENU	1	EN < 3 μs DIS < 2.25 μs	US GSU_UV (0x02 [D6])	No (Disabled)	(0x02 [D2]) Always=0	1	11 µs	-				
60730		VBAT	(0x07 [D2])	0	1.5 ms			SU_UV	0	1.4 ms	0.8 ms				
	1	disconnect		1	EN < 3 μs DIS < 2.25 μs		Yes	(0x02 [D2])	1	11 µs	11 µs				
		Dhase	ENV	0	10 ms	GSV UV			0	1.4 ms	-				
GV / SV	X	Phase disconnect	(0x07 [D1])	1	EN < 3 μs DIS < 2.25 μs	(0x02 [D5])	No	-	1	11 µs	-				
		Dhasa	nase ENW 0 10 ms GSW UV			0	1.4 ms	-							
GW / SW	GW / SW X	Phase disconnect					(0x07 [D0])	1	EN < 3 μs DIS < 2.25 μs	GSW_UV (0x02 [D4])	No	-	1	11 µs	_



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

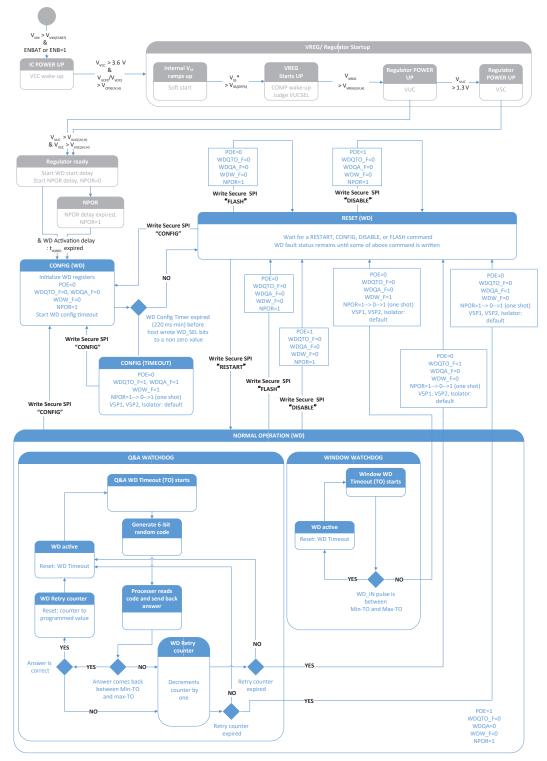


Figure 6: Watchdog State Diagram



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

### SERIAL COMMUNICATION INTERFACE

The ARG82801 provides the user with a three-wire synchronous serial interface that is compatible with SPI (serial peripheral interface). A fourth wire can be used to provide diagnostic feedback and readback of the register content.

The serial interface timing requirements are specified in the electrical characteristics table and illustrated in the serial interface timing diagram (Figure 1). Data is received on the SDI terminal and clocked through a shift register on the rising edge of the clock signal input on the SCK terminal. STRn is normally held high and is only brought low to initiate a serial transfer. No data is clocked through the shift register when STRn is high, allowing multiple SDI peripheral units to use common SDI, SCK, and SDO connections. Each peripheral then requires an independent STRn connection.

When 16 data bits have been clocked into the shift register, STRn must be taken high to latch the data into the selected register. When this occurs, the internal control circuits act on the new data and the diagnostic register is reset.

If there are more than 16 rising edges on SCK or if STRn goes high and there are fewer than 16 rising edges on SCK, the write is cancelled without writing data to the registers. In addition, the diagnostic register is not reset and the SE (serial error) bit is set to indicate a data transfer error. Diagnostic information or the contents of the configuration and control registers is output on the SDO terminal MSB first while STRn is low, and changes to the next bit on each falling edge of SCK. The first bit, which is always the FF (fault flag) bit from the Diagnostic register, is output as soon as STRn goes low.

Each of the programmable (configuration and control) registers has a write bit, WR (bit 10), as the first bit after the register address. This bit must be set to 1 to write the subsequent bits into the selected register. If WR is set to 0, then the remaining data bits (bits 9 to 0) are ignored. The state of the WR bit also determines the data output on SDO. If WR is set to 1, then the Diagnostic register is output. If WR is set to 0, then the contents of the register selected by the first five bits is output. In all cases, the first bit output on SDO is always the FF bit from the diagnostic register.

The ARG82801 has 15 register banks. Bit <15:11> represents the register address for read and write. Bit <10> detects the read and write operation. For write operation, Bit <10> = 1, and for read operation, bit value is logic low. Bit <9> is an unused bit. Maximum data size is eight bits, so bit <8:1> represents the data word. The last bit in the serial transfer, bit <0> is parity bit that is set to ensure odd parity in the complete 16-bit word. Odd parity means that the total number of 1's in any transmission should always be an odd number. This ensures that there is always at least one bit

#### Pattern at SDI Pin

MSB															LSB
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
A4	A3	A2	A1	A0	W/R	NU	D7	D6	D5	D4	D3	D2	D1	D0	Р
	5	-Bit Addres	S							8-Bit	Data	·			

#### Pattern at SDO Pin after SDI Write

MSB															LSB
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DBE	FF	SE	ENBATS	WDW_F	WDQTO_F	WDQA_F	VREG_OK	VCC_OK	VCP_OK	VUC_OK	V5C_OK	0	0	0	Р
						[	Diagnostics								

#### Pattern at SDO Pin after SDI Read

MSB															LSB
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DBE	FF	SE	ENBATS	WDW_F	WDQTO_F	WDQA_F	D7	D6	D5	D4	D3	D2	D1	D0	Р
	Diagnostics						8-Bit Data								



set to 1 and one bit set to 0 and allows detection of stuck-at faults on the serial input and output data connections. The parity bit is not stored but generated on each transfer.

Register data is output on the SDO terminal MSB first while STRn is low and changes to the next bit on each falling edge of the SCK. The first bit, which is always the FF bit from the status register, is output as soon as STRn goes low.

If there are more than 16 rising edges on SCL or if STRn goes high and there are fewer than 16 rising edges on SCK, the write is cancelled without writing data to the registers. In addition, the diagnostic register is not reset and the SE bit is set to indicate a data transfer error.

**SDI:** Serial data logic input with pull down. 16-bit serial word input MSB first.

**SCK:** Serial clock logic input with pull-down. Data is latched in from SDI on the rising edge of SCL. There must be 16 rising edges per write and SCK must be held high when STRn changes.

**STRn:** Serial data strobe and serial access enable logic input with pull-up. When STRn is high, any activity on SCK or SDI is ignored and SDO is high impedance, allowing multiple SDI peripherals to have common SDI, SCK, and SDO connections.

**SDO:** Serial data output. High impedance when STRn is high. Output bit 15 of the status register, the fault flag (FF) as soon as STRn goes low.

## **Register Mapping**

### STATUS REGISTERS

The ARG82801 provides three status registers. These registers are read only. They provide real-time status of various functions within the ARG82801.

These registers report on the status of all four system rails. They also report on internal rail status, including the charge pump, VREG, and VCC rails. The general fault flag and watchdog fault state are found in these status registers.

The logic that creates the power-on enable and power reset status are reported through these registers.

#### **CONFIGURATION REGISTERS**

The ARG82801 allows configuration of the watchdog validation parameters and disabling dithering function.

The watchdog can only be configured during CONFIG state. This occurs when the ARG82801 is initially enabled or the watchdog is restarted through SPI.

The ARG82801 uses frequency dithering for pre-regulator to help reduce EMC noise. The user can disable this feature through the SPI. Default is enabled.

All WD configuration must be entered before modifying the WD\_ SEL bits, meaning CONFIG\_1 must be written before CONFIG\_0.

#### **DIAGNOSTIC REGISTERS**

There are multiple diagnostic registers in the ARG82801. These registers can be read to evaluate the status of the ARG82801. The high-level registers indicate which area a fault has occurred. Logic high on a data bit in this register implies that no fault has occurred. The following are monitored by these registers:

- All four outputs
- ARG82801 bias voltage
- Charge pump voltage
- Pre-regulator voltage
- Overtemperature
- · Watchdog output
- Shorts on LX pin or open diode on pre-regulator

Note some of these faults cause the ARG82801 to shut down, which might shutdown the microprocessor monitoring the SPI. In this event, the only way to read the fault would be to have alternative power to the microprocessor so it can read the registers. If  $V_{CC}$  of the ARG82801 shuts down, all stored register information is lost and the registers revert back to default values.

Other diagnostic registers store more details on each fault, this includes:

- Overvoltage on a particular output or internal rail
- Undervoltage on a particular output or internal rail

The diagnostic registers are latch registers and hold data if a fault has occurred but recovered. These registers are reset by writing a 1 to them.

#### **OUTPUT ENABLE/DISABLE REGISTER**

The output enable/disable register provides the user control of the LDO outputs and isolator drivers. For LDO control, two bits must be set high to enable an output. If only one bit is high, then the 5 V outputs remain off.

#### WATCHDOG MODE KEY REGISTER

At times, it may be necessary to re-flash or restart the processor. To do this, the user must put the watchdog into FLASH mode or RESTART. This is done by writing a sequence of key words to the WATCHDOG\_MODE\_KEY register. If the correct word sequence is not received, then the sequence must restart.



Once flash is complete, the processor must send the restart sequence of keywords for the watchdog to exit FLASH mode. If  $V_{CC}$  has not been removed from the ARG82801, the watchdog restarts with the current configuration.

#### VERIFY RESULT REGISTERS

On every startup, the ARG82801 performs a self-test of the UV and OV detect circuits. This test should cause the diagnostic registers to toggle state. If the diagnostic register successfully changes state, the verify result register latches high. Upon completion of startup, the system's microprocessor can check the verify result registers to see if the self-test passed.

#### Table 5: Register Map

Hex Address	Register Name	DEC Address	Туре	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
0x00	STATUS_0	0	RO	FF	POE_OK	SE	NPOR_S	NPOR_OK	WDW_F	WDQTO_F	WDQA_F	
0x01	STATUS_1	1	RO		VCC_OK	VCP_OK	VREG_OK	VUC_OK	V5C_OK	V5P1_OK	V5P2_OK	
002	STATUS 2	2	RO	GSVBB_UV	GSU_UV	GSV_UV	GSW_UV			POE_S	ENBAT_S	
0x02	51ATU5_2	2	RW1C					SVBB_UV	SU_UV			
0x03	STATUS_3	3	RO	CLK_ST_H	CLK_ST_L	ENB_S	DBE	TSD_OK	LG_OK	LX_OK	D1_OK	
0x04	DIAG_0	4	RW1C			VDD_UV	VCC_UV	VCP_OV	VCP_UV	V5P2_OV	V5P2_UV	
0x05	DIAG_1	5	RW1C	VREG_OV	VREG_UV	VUC_OV	VUC_UV	V5C_OV	V5C_UV	V5P1_OV	V5P1_UV	
0x06	OUTPUT_ENABLE / DISABLE_0	6	RW				V5P1_EN1	V5P2_EN1		V5P1_EN0	V5P2_EN0	
0x07	OUTPUT_ENABLE / DISABLE_1	7	RW					ENVBB	ENU	ENV	ENW	
0x08	CONFIG_0	8	RW	WD_SEL_1	WD_SEL_0	TRY_1	TRY_0	TIMER_3	TIMER_2	TIMER_1	TIMER_0	
0x09	CONFIG_1	9	RW	GD_UV_FLT	GD_EN_DLY	GD_U_SEL	FFN_SEL	WIN_TIMER_2	WIN_TIMER_1	WIN_TIMER_0	DITH_DIS	
0x0A	Q&A WATCHDOG	10	RW			RND_5	RND_4	RND_3	RND_2	RND_1	RND_0	
0x0B	WATCHDOG_SECURE_KEY	11	WO	Keycode entry (White only)								
0x0C	AMUXOUT	12	RW					SEL_MUX_3	SEL_MUX_2	SEL_MUX_1	SEL_MUX_0	
0x0D	VERIFY_RESULT_0	13	RW1C	BIST_FAIL	TSD_FAIL	VREG_OV_FAIL	VREG_UV_FAIL	VUC_OV_FAIL	VUC_UV_FAIL	V5C_OV_FAIL	V5C_UV_FAIL	
0x0E	VERIFY_RESULT_1	14	RW1C					V5P1_OV_FAIL	V5P1_UV_FAIL	V5P2_OV_FAIL	V5P2_UV_FAIL	

Register Types:

RO = Read-Only RW = Read or Write RW1C = Read or Write 1 to clear WO = Write-Only



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

#### 0x00: STATUS REGISTER 0

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		5-bit Address					NU	8-bit Data								
STATUS_0	A4	A3	A2	A1	A0	Туре	NU	D7	D6	D5	D4	D3	D2	D1	D0	
	0	0	0	0	0			FF	POE_OK	SE	NPOR_S	NPOR_OK	WDW_F	WDQTO_F	WDQA_F	Б
		0 0	0	0	RO	0	0	0	0	0	0	0	0	0	Р	

FF	Fault Flag	
0	No Fault	Default
1	Fault	

SE	Serial Error Flag <sup>[1]</sup>	
0	No Fault	Default
1	Fault	

NPOR_OK	NPOR Signal matches what device is demanding	
0	Fault	Default
1	No Fault	

WDQTO_F	Q&A Watchdog Timeout Fault Flag	
0	Q&A watchdog off or No fault	Default
1	Q&A watchdog Timeout fault	

POE_OK	Power-on enable signal matches what ARG82801 is demanding	
0	Fault	Default
1	No Fault	

NPOR_S	Power-On Reset Internal Logic Status	
0	NPOR is Low	Default
1	NPOR is High	

WDW_F	Window Watchdog Fault Flag	
0	No Fault or Window Watchdog is disabled	Default
1	Fault	

WDQA_F	Q&A Watchdog Answer Fault Flag	
0	Q&A watchdog off or No fault	Default
1	Q&A watchdog Answer fault	

<sup>[1]</sup> SE Fault: If more than sixteen rising edges on SCK are detected while STRn is LOW or if STRn goes high and there are fewer than sixteen rising edges on SCK.

#### 0x01: STATUS REGISTER 1

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		5-bit Address					NU	8-bit Data								
STATUS_1	A4	A3	A2	A1	A0	Туре	NU	D7	D6	D5	D4	D3	D2	D1	D0	
	0	0	0	0	1	RO			VCC_OK	VCP_OK	VREG_OK	VUC_OK	V5C_OK	V5P1_OK	V5P2_OK	P
		0	0	0	0	'		0	0	0	0	0	0	0	0	0

<b>VCC_ОК</b>	VCC Output Rail is OK	
0	Fault (UV)	Default
1	No Fault	

VREG_OK	VREG Output Rail is OK	
0	Fault (UV or OV)	Default
1	No Fault	

V5C_OK	V5C Output Rail is OK	
0	Fault (UV or OV)	Default
1	No Fault	

V5P2_OK	V5P2 Output Rail is OK	
0	Fault (UV or OV)	Default
1	No Fault	

VCP_OK	Charge Pump Output Rail is OK	
0	Fault (VCP1-UV, VCP1-OV or VCP2-UV)	Default
1	No Fault	

VUC_OK	VUC Output Rail is OK	
0	Fault (UV or OV)	Default
1	No Fault	

V5P1_OK	V5P1 Output Rail is OK	
0	Fault (UV or OV)	Default
1	No Fault	



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

#### 0x02: STATUS REGISTER 2

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
5-bit Address		Turno	NU	8-bit Data												
0747110 0	A4	A3	A2	A1	A0	Туре	NU	D7	D6	D5	D4	D3	D2	D1	D0	
STATUS_2						RO		GSVBB_UV	GSU_UV	GSV_UV	GSW_UV			POE_S	ENBAT_S	
	0	0	0	1	0	RW1C						SVBB_UV	SU_UV			Р
							0	0	0	0	0	0	0	0	0	

GSVBB_UV	GVBB - SVBB Undervoltage Status	
0	OK (Undervoltage is not detected or ENVBB=0)	Default
1	Undervoltage	

GSV_UV	GV - SV Undervoltage Status	
0	OK (Undervoltage is not detected or ENV=0)	Default
1	Undervoltage	

SVBB_UV	SVBB - GND Undervoltage Status	
0	OK (Undervoltage is not detected)	Default
1	Undervoltage	

POE_S	Power-On Enable Internal Logic Status	
0	POE is low	Default
1	POE is high	

GSU_UV	GU - SU Undervoltage Status	
0	OK (Undervoltage is not detected or ENU=0)	Default
1	Undervoltage	

GSW_UV	GW - SW Undervoltage Status	
0	OK (Undervoltage is not detected or ENW=0)	Default
1	Undervoltage	

SU_UV	SU - GND Undervoltage Status	
0	OK (Undervoltage is not detected or GD_U_SEL=0)	Default
1	Undervoltage (GD_U_SEL=1)	

ENBAT_S	Battery Enable (ENBAT) Status	
0	ENBAT is low	Default
1	ENBAT is high	

#### 0x03: STATUS REGISTER 3

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	5-bit Address		Turno	NUL	8-bit Data											
STATUS_3	A4	A3	A2	A1	A0	Туре	Type NU -	D7	D6	D5	D4	D3	D2	D1	D0	
	0	0	0	1	1	RO		CLK_ST_H	CLK_ST_L	ENB_S	DBE	TSD_OK	LG_OK	LX_OK	D1_OK	ь
				0	0	0	0	0	0	0	0	0	F			

CLK_ST_H	Indicates the internal clock is stuck high	
0	Internal clock is not stuck high	Default
1	Internal clock is stuck high	

ENB_S	Logic Enable (ENB) Status	
0	ENB is low	Default
1	ENB is high	

TSD_OK	SD_OK Thermal Shutdown (Overtemperature) Detection Flag		
0	Overtemperature is detected	Default	
1	OK (Overtemperature is not detected)		

LX_OK	Pre-Regulator SW-Node (LX) Fault Detection Flag	
0	Fault on LX is detected	Default
1	OK (LX is working correctly)	

CLK_ST_L	CLK_ST_L Indicates the internal clock is stuck low			
0	Internal clock is not stuck low	Default		
1	Internal clock is stuck low			
DBE	EEPROM Dual Bit Error Flag <sup>[1]</sup>			
0	No fault	Default		

1	Fault	
LG_OK	Pre-Regulator Boost Gate Drive Output (LG) Status	

LG_OK	LG_OK Output (LG) Status			
0	Fault on LG is detected	Default		
1	OK (LG is working correctly)			

D1_OK	Pre-Regulator Asynchronous Diode (D1) Missing Detection Status	
0	Fault (D1 missing is detected)	Default
1	OK (D1 missing is not detected)	

<sup>[1]</sup> DBE Fault: it means that a dual-bit error occurred loading the trim data from EEPROM.



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

#### 0x04: DIAG REGISTER 0

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
	5-bit Address				Turne NUL		Time					8-bit	Data					
DIAG_0	A4	A3	A2	A1	A0	Type NU	D7	D6	D5	D4	D3	D2	D1	D0				
	0 0 1	0	1 0	1	0	0	DW/1C	RW1C				VDD_UV	VCC_UV	VCP_OV	VCP_UV	V5P2_OV	V5P2_UV	Б
0		0 0	U RWIC	0	0	0	0	0	0	0	0	0	F					

VDD_UV	VDD Output Undervoltage Detection	
0	OK (Undervoltage is not detected)	Default
1	Undervoltage is detected	

VCP_OV	VCP Output Overvoltage Detection	
0	OK (VCP1 Overvoltage is not detected)	Default
1	VCP1 Overvoltage is detected	

V5P2_OV	V5P2 Output Overvoltage Detection	
0	OK (Overvoltage is not detected)	Default
1	Overvoltage is detected	

vcc_uv	VCC Output Undervoltage Detection	
0	OK (Undervoltage is not detected)	Default
1	Undervoltage is detected	

VCP_UV	VCP Output Undervoltage Detection	
0	OK (VCP1 and VCP2 Undervoltage is not detected)	Default
1	VCP1 or VCP2 Undervoltage is detected	

V5P2_UV	V5P2 Rail Over Undervoltage Detection	
0	OK (Undervoltage is not detected)	Default
1	Undervoltage is detected	

#### 0x05: DIAG REGISTER 1

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	5-bit Address					Type NU				8-bit	Data					
DIAG_1	A4	A3	A2	A1	A0	Type NU	D7	D6	D5	D4	D3	D2	D1	D0		
		0 0 1 0 1 RW1C		VREG_OV	VREG_UV	VUC_OV	VUC_UV	V5C_OV	V5C_UV	V5P1_OV	V5P1_UV	в				
0		0		RWIC	0	0	0	0	0	0	0	0	0	Г		

VREG_OV	VREG Output Overvoltage Detection	
0	OK (Overvoltage is not detected)	Default
1	Overvoltage is detected	

VUC_OV	VUC Output Overvoltage Detection	
0	OK (Overvoltage is not detected)	Default
1	Overvoltage is detected	

V5C_OV	V5C Output Overvoltage Detection	
0	OK (Overvoltage is not detected)	Default
1	Overvoltage is detected	

V5P1_OV	V5P1_OV V5P1 Output Overvoltage Detection				
0	OK (Overvoltage is not detected)	Default			
1	Overvoltage is detected				

VREG_UV	/REG_UV VREG Output Undervoltage Detection				
0	Default				
1					

VUC_UV	VUC Output Undervoltage Detection	
0	OK (Undervoltage is not detected)	Default
1 Undervoltage is detected		

V5C_UV	V5C Output Undervoltage Detection	
0	OK (Undervoltage is not detected)	Default
1	Undervoltage is detected	

V5P1_UV	_UV V5P1 Output Undervoltage Detection				
0	OK (Undervoltage is not detected)	Default			
1	Undervoltage is detected				





#### 0x06: OUTPUT ENABLE/DISABLE REGISTER 0

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Output					Trans	NU				8-bit	Data					
Enable/ Disable	A4	A3	A2	A1	A0	Туре	NU	D7	D6	D5	D4	D3	D2	D1	D0	
REGISTER_0	0	0	1	1	0	RW					V5P1_EN1	V5P2_EN1		V5P1_EN0	V5P2_EN0	Р
	0	0	I		0	RVV	0	0	0	0	0	0	0	0	0	F

V5P1_EN1	V5P1_EN0	Enable V5P1	
0	0	V5P1 is disabled	Default
0	1	V5P1 is disabled	
1	0	V5P1 is disabled	
1	1	V5P1 is enabled	

V5P2_EN1	V5P2_EN0	Enable V5P2	
0	0	V5P2 is disabled	Default
0	1	V5P2 is disabled	
1	0	V5P2 is disabled	
1	1	V5P2 is enabled	

#### 0x07: OUTPUT ENABLE/ DISABLE REGISTER 1

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Output					Turne	Type NU				8-bit	Data					
Enable/ Disable	A4	A3	A2	A1	A0	Туре	NU	D7	D6	D5	D4	D3	D2	D1	D0	
REGISTER_1	0	0	1	1	1	RW						ENVBB	ENU	ENV	ENW	P
	0	0				r.vv	0	0	0	0	0	0	0	0	0	

ENVBB		
0	Disabled	Default
1	Enabled	

ENV		
0	Disabled	Default
1	Enabled	

ENU	Enable GU-Gate driver	
0	Disabled	Default
1	Enabled	

ENW	Enable GW-Gate driver	
0	Disabled	Default
1	Enabled	





#### 0x08: CONFIGURATION REGISTER 0

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		ţ	5-bit Address	6		Turne	vpe NU -				8-bit	Data				
CONFIG_0	A4	A3	A2	A1	A0	Type NU	D7	D6	D5	D4	D3	D2	D1	D0		
	0	1	0	0	0	RW		WD_SEL_1	WD_SEL_0	TRY_1	TRY_0	TIMER_3	TIMER_2	TIMER_1	TIMER_0	D
	U 1	1 0	0		0	1.00	0	0	0	0	0	0	0	0	0	F

WD_SEL_1	WD_SEL_0	Watchdog	
0	0	Default (WD waiting for config)	Default
0	1	Window watchdog only	
1	0	Q&A watchdog only	
1	1	Both (Window and Q&A)	

TRY_1	TRY_0	Acceptable Number of Mis-Refresh	
0	0	0	Default
0	1	1 time	
1	0	3 times	
1	1	7 times	

Timer3	Timer2	Timer1	Timer0	Min. Timeout <sup>[1]</sup>	Max. Timeout <sup>[1]</sup>	
0	0	0	0	0.5 ms	1 ms	Default
0	0	0	1	1 ms	2 ms	
0	0	1	0	2 ms	4 ms	
0	0	1	1	4 ms	8 ms	
0	1	0	0	8 ms	16 ms	
0	1	0	1	12 ms	24 ms	
0	1	1	0	16 ms	32 ms	
0	1	1	1	24 ms	48 ms	
1	0	0	0	32 ms	64 ms	
1	0	0	1	40 ms	80 ms	
1	0	1	0	64 ms	128 ms	
1	0	1	1	72 ms	144 ms	
1	1	0	0	80 ms	160 ms	
1	1	0	1	96 ms	192 ms	
1	1	1	0	128 ms	256 ms	
1	1	1	1	144 ms	288 ms	

<sup>[1]</sup> Typical number at the internal clock is center value, need to keep enough margin for  $\pm 5\%$  tolerance of the clock.





0x09: CONFIGURATION REGISTER 1

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		Ę	5-bit Addres	s		Туре	NU	8-bit Data								
CONFIG_1	A4	A3	A2	A1	A0	Type NO	D7	D6	D5	D4	D3	D2	D1	D0		
	0	1	0	0	1	RW		GD_UV_FLT	GD_EN_DLY	GD_U_SEL	FFn_SEL	WIN_ TIMER_2	WIN_ TIMER_1	WIN_ TIMER_0	DITH_DIS	Р
							0	0	0	0	0	0	0	0	0	
			Bit D7, I	06, GD_U_S	EL: Select	Gate Drive	UV filter an	d enable/di	isable delay							
									isable delay ndervoltage							
				GD_UV_FL		GD_	EN_DLY		Delay T			Enable Dela	ly			
				0			0		Slov	v		Slow				
				1			х		Fast			-				
		X				1			_			Fast				

		Select Gate Drive GU/SU Node	Function	
GD_U_SEL	ENU Gate Driver Enable/Disable Delay (typ)	SU-UV	Note	
0	10 ms	Disabled	GU/SU is used for phase isolator	Default
1	1.5 ms	Enabled	GU/SU is used for VBAT disconnect	

FFn_SEL	Signal on FFn Pin	
0	Fault-Low	Default
1	50 Hz (nominal) clock signal output; independent from fault flag	

WIN_TIMER_2	WIN_TIMER_1	WIN_TIMER_0	Window Watchdog Error Timeout (Min.) [1]	Window Watchdog Error Timeout (Max.) <sup>[1]</sup>	
0	0	0	0.5 ms	4 ms	Default
0	0	1	1 ms	8 ms	
0	1	0	2 ms	16 ms	
0	1	1	4 ms	32 ms	
1	0	0	6 ms	42 ms	
1	0	1	8 ms	64 ms	
1	1	0	10 ms	80 ms	
1	1	1	12.5 ms	100 ms	

<sup>[1]</sup> Typical number at the internal clock is center value, need to keep enough margin for ±5% tolerance of the clock.

DITH_DIS	Disable Dithering Function	
0	Dithering is enabled	Default
1	Dithering is disabled	

#### 0x0A: Q&A WATCHDOG REGISTER

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Q&A WD		1	0	1	0	RW				RND_5	RND_4	RND_3	RND_2	RND_1	RND_0	P
QOA WD	0	1	0		0	1.00	0	0	0	0	0	0	0	0	0	F'





#### 0x0B: WATCHDOG SECURE KEY REGISTER

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
WD								KEY_7	KEY_6	KEY_5	KEY_4	KEY_3	KEY_2	KEY_1	KEY_0	
SECURE KEY	0	1	0	1	1	WO	0	0	0	0	0	0	0	0	0	Р

Three 8-bit words must be sent in the correct order to enable flash mode, configuration mode, Watchdog restart, or disable the Watchdog for debugging purpose. If an incorrect word is received, then the register resets and the first word has to be resent.

	Flash Mode	Configuration Mode	Watchdog Restart	Watchdog Disable
WORD1	0xD3	0xD3	0xD3	0xD3
WORD2	0x33	0x33	0x33	0x33
WORD3	0xCC	0xCD	0xCE	0xCF

#### 0x0C: ANALOG MUX OUTPUT REGISTER

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	0	4	4	0	0	DW/						SEL_MUX_3	SEL_MUX_2	SEL_MUX_1	SEL_MUX_0	P
AMUXOUT	0	1	1	0	0	RW	0	0	0	0	0	0	0	0	0	Р

SEL_MUX_3	SEL_MUX_2	SEL_MUX_1	SEL_MUX_0	MUX Output (Signal Divided Ratio)	
0	0	0	0	VREG (1/2)	Default
0	0	0	1	VUC (1/2)	
0	0	1	0	V5C (1/2)	
0	0	1	1	V5P1 (1/2)	
0	1	0	0	V5P2 (1/2)	
0	1	0	1	ENBAT (1/8)	
0	1	1	0	BG1 (1/1)	
0	1	1	1	BG2 (1/1)	
1	0	0	0	TEMP (n/a) Output (mV) = 1440 mV − 3.92 mV/°C × T <sub>J</sub> (°C)	
1	0	0	1	VIN (1/10)	
1	0	1	0	VCP1 (1/12)	
1	0	1	1	VCP2 (1/12)	



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

#### 0x0D: VERIFY REGISTER 0

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		ţ	5-bit Address	6		Tuno	NU				8-bit	Data				
VERIFY_0	A4	A3	A2	A1	A0	Туре	NU	D7	D6	D5	D4	D3	D2	D1	D0	
	0	1	1	0	1	RW1C	W1C	BIST_FAIL	TSD_FAIL	VREG_OV_ FAIL	VREG_UV_ FAIL	VUC_OV_ FAIL	VUC_UV_ FAIL	V5C_OV_ FAIL	V5C_UV_ FAIL	P
							0	0	0	0	0	0	0	0	0	

BIST_FAIL	Built-In Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

VREG_OV_FAIL	VREG Overvoltage Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

VUC_OV_FAIL	VUC Overvoltage Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

V5C_OV_FAIL	V5C Overvoltage Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

TSD_FAIL	Thermal Shutdown Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

VREG_UV_FAIL	VREG Undervoltage Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

VUC_UV_FAIL	VUC Undervoltage Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

V5C_UV_FAIL	V5C Undervoltage Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

#### 0x0E: VERIFY REGISTER 1

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
VERIFY_1	0	1	1	1	0	RW1C						V5P1_OV_ FAIL	V5P1_UV_ FAIL	V5P2_OV_ FAIL	V5P2_UV_ FAIL	Р
_							0	0	0	0	0	0	0	0	0	

V5P1_OV_FAIL	V5P1 Overvoltage Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

V5P2_OV_FAIL	V5P2 Overvoltage Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

V5P1_UV_FAIL	V5P1 Undervoltage Self-Test Result Flag	
0	Self-test passed	Default
1	Self-test failed	

V5P2_UV_FAIL		V5P2 Undervoltage Self-Test Result Flag	
0		Self-test passed	Default
1		Self-test failed	



## Fully Integrated PMIC for Safety-Related Systems with Buck or Buck-Boost Pre-Regulator, 4× Linear Regulators, 4× Gate Drivers, and SPI

### DESIGN AND COMPONENT SELECTION

The following section briefly describes the component selection procedure for the ARG82801.

#### Setting up the Pre-Regulator

This section discusses the component selection for the ARG82801 pre-regulator. It covers the charge pump circuit, inductor, diodes, boost MOSFET, and input and output capacitors. It also covers loop compensation.

### **Charge Pump Capacitors**

The charge pump circuits require two capacitors: VCP1, a 2.2  $\mu$ F connected from pin VCP1 to VIN and 1  $\mu$ F connected between pins CP1C1 and CP1C2; and VCP2, a 1  $\mu$ F connected from pin VCP2 to VCP1 and 0.22  $\mu$ F connected between pins CP2C1 and CP2C2. These capacitors should be high-quality ceramic capacitors, such as an X5R or X7R, with a voltage rating of at least 16 V.

### **PWM Switching Frequency**

The switching frequency of the ARG82801 is fixed at 2.2 MHz nominal. The ARG82801 includes a frequency foldback scheme that starts when  $V_{IN}$  is greater than 18 V. Between 18 V and 36 V, the switching frequency will foldback from 2.2 MHz typical to 1 MHz typical. The switching frequency for a given input voltage above 18 V and below 36 V is:

$$f_{SW} = 3.4 - \frac{1.2}{18} \times V_{VIN} (MHz)$$
 (1)

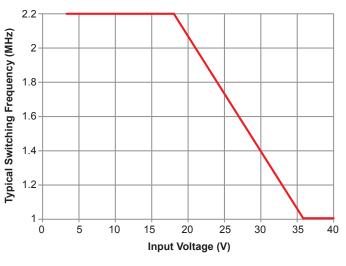


Figure 7: Typical Switching Frequency versus Input Voltage

#### **Pre-Regulator Output Inductor**

For peak current-mode control, it is well known that the system becomes unstable when the duty cycle is above 50% without adequate Slope Compensation ( $S_E$ ). However, the slope compensation in the ARG82801 is a fixed value. Therefore, it is important to calculate an inductor value so the falling slope of the inductor current ( $S_F$ ) works well with the ARG82801's slope compensation.

Equation 2 can be used to calculate a range of values for the output inductor for the buck-boost. In equation 2, slope compensation can be found in the Electrical Characteristic table,  $V_F$  is the asynchronous diode's forward voltage,  $S_E$  is in A/µs, and L is in µH:

$$\frac{(V_{VREG} + V_F)}{S_E} \leq L \leq \frac{2 \times (V_{VREG} + V_F)}{S_E}$$
(2)

If equation 2 yields an inductor value that is not a standard value, then the next closest available value should be used. The final inductor value should allow for 10% to 20% of initial tolerance and 20% to 30% for inductor saturation.

Due to topology and frequency switching of the ARG82801 preregulator, the inductor ripple current varies with input voltage per Figure 8 below:

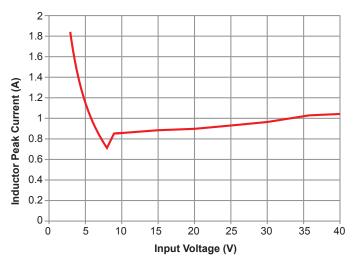


Figure 8: Typical Peak Inductor Current versus Input Voltage for 0.8 A Output Current and 10 µH Inductor



The inductor should not saturate given the peak operating current during overload. Equation 3 calculates this current. In equation 3,  $V_{VIN(MAX)}$  is the maximum continuous input voltage, such as 16 V, and  $V_F$  is the asynchronous diode's forward voltage.

$$I_{PEAK} = I_{LIM(ton,min)max} - \frac{S_E \times (V_{VREG} + V_F)}{0.9 \times f_{SW} \times (V_{VIN(MAX)} + V_F)}$$
(3)

After an inductor is chosen, it should be tested during output overload and short-circuit conditions. The inductor current should be monitored using a current probe. A good design should ensure the inductor or the regulator are not damaged when the output is shorted to ground at maximum input voltage and the highest expected ambient temperature.

Inductor ripple current can be calculated using equation 4 for buck mode, and equation 5 for buck-boost mode.

$$\Delta I_{L} = \frac{(V_{VIN} - V_{VREG}) \times V_{VREG}}{f_{SW} \times L \times V_{VIN}}$$
(4)

$$\Delta I_{L(B/B)} = \frac{V_{VIN} \times D_{BOOST}}{f_{SW} \times L}$$
(5)

#### **Pre-Regulator Output Capacitors**

The output capacitors filter the output voltage to provide an acceptable level of ripple voltage. They also store energy to help maintain voltage regulation during a load transient. The voltage rating of the output capacitors must support the output voltage with sufficient design margin.

The output voltage ripple ( $\Delta V_{VREG}$ ) is a function of the output capacitors parameters:  $C_O$ , ESR<sub>CO</sub>, ESL<sub>CO</sub>.

$$\Delta V_{VREG} = \Delta I_L \times ESR_{CO} +$$

$$\frac{V_{VIN} - V_{VREG}}{L} \times ESL_{CO} +$$

$$\frac{\Delta I_L}{8 \times f_{SW} \times C_O}$$
(6)

The type of output capacitors determines which terms of equation 6 are dominant. For ceramic output capacitors, the  $ESR_{CO}$  and  $ESL_{CO}$  are virtually zero, so the output voltage ripple is dominated by the third term of equation 6.

$$\Delta V_{VREG} = \frac{\Delta I_L}{8 \times f_{SW} \times C_O} \tag{7}$$

To reduce the voltage ripple of a design using ceramic output capacitors, simply increase the total capacitance, reduce the inductor current ripple (i.e. increase the inductor value), or increase the switching frequency.

The transient response of the regulator depends on the number and type of output capacitors. In general, minimizing the ESR of the output capacitance results in a better transient response. The ESR can be minimized by simply adding more capacitors in parallel or by using higher quality capacitors. At the instant of a fast load transient (di/dt), the output voltage changes by the amount:

$$\Delta V_{VREG} = \Delta I_{LOAD} \times ESR_{CO} + \frac{di}{dt} \times ESL_{CO}$$
(8)

After the load transient occurs, the output voltage deviates from its nominal value for a short time. This time depends on the system bandwidth, the output inductor value, and output capacitance. Eventually, the error amplifier brings the output voltage back to its nominal value.

The speed at which the error amplifier brings the output voltage back to its setpoint depends mainly on the closed-loop bandwidth of the system. A higher bandwidth usually results in a shorter time to return to the nominal voltage. However, a higher bandwidth system may be more difficult to obtain acceptable gain and phase margins. Selection of the compensation components ( $R_Z$ ,  $C_Z$ ,  $C_P$ ) are discussed in more detail in the Compensation Components section of this datasheet.

#### **Ceramic Input Capacitors**

The ceramic input capacitor(s) must limit the voltage ripple at the VIN pin to a relatively low voltage during maximum load. Equation 8 can be used to calculate the minimum input capacitance,

$$C_{IN} \ge \frac{I_{VREG(MAX)} \times 0.25}{0.90 \times f_{SW} \times 50 \ mV}$$
(9)

where I<sub>VREG(MAX)</sub> is the maximum current from the pre-regulator,

$$I_{VREG(MAX)} = I_{LINEAR} + I_{AUX} + 20 mA$$
(10)

where  $I_{LINEAR}$  is the sum of all the internal linear regulators output currents,  $I_{AUX}$  is any extra current drawn from the VREG output to power other devices external to the ARG82801.

A good design should consider the DC bias effect on a ceramic capacitor—as the applied voltage approaches the rated value, the capacitance value decreases. The X5R and X7R type capacitors should be the primary choices due to their stability versus both



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DC bias and temperature. For all ceramic capacitors, the DC bias effect is even more pronounced on smaller case sizes, so a good design uses the largest affordable case size.

Also for improved noise performance, it is recommended to add smaller sized capacitors close to the input pin and the D1 anode. Use a 0.1  $\mu F$  0603 capacitor or less.

## Buck-Boost Asynchronous Diode (D1)

The highest peak current in the asynchronous diode (D1) occurs during overload and is limited by the ARG82801. Equation 3 can be used to calculate this current.

The highest average current in the asynchronous diode occurs when  $V_{VIN}$  is at its maximum,  $D_{BOOST} = 0\%$ , and  $D_{BUCK} = minimum$  (10%),

$$I_{AVG} = 0.9 \times I_{VREG(MAX)} \tag{11}$$

where  $I_{VREG(MAX)}$  is calculated using equation 10.

### **Boost MOSFET (Q1)**

The RMS current in the boost MOSFET (Q1) occurs when  $V_{\rm VIN}$  is at its minimum and both the buck and boost operate at their maximum duty cycles (approximately 64% and 58%, respectively),

$$I_{QI(RMS)} = \sqrt{D_{BOOST} \times \left[ \left( I_{PEAK} - \frac{\Delta I_{L(B/B)}}{2} \right)^2 + \frac{\Delta I_{L(B/B)}}{12} \right]^2} \qquad (12)$$

where  $\Delta I_{L(B/B)}$  and  $I_{PEAK}$  are derived using equations 3 and 5, respectively.

### Boost Diode (D2)

In buck mode, this diode simply conducts the output current. However, in buck-boost mode, the peak currents in this diode may increase a lot. The ARG82801 limits the peak current to the value calculated using equation 3. The average current is simply the output current.

# Pre-Regulator Compensation Components $(R_Z, C_Z, C_P)$

Although the ARG82801 can operate in buck-boost mode at low input voltages, it still can be considered a buck converter when looking at the control loop. The following equations can be used to calculate the compensation components.

First, select the target crossover frequency for the final system.

While switching at over 2 MHz, the crossover is governed by the required phase margin. Since a type II compensation scheme is used, the system is limited to the amount of phase that can be added. Hence, a crossover frequency,  $f_C$ , in the region of 55 kHz is selected. The total system phase drops off at higher crossover frequencies. The  $R_Z$  selection is based on the gain required at the crossover frequency and can be calculated by the following simplified equation:

$$R_Z = \frac{13.36 \times \pi \times f_C \times C_O}{gm_{POWER} \times gm_{EA}}$$
(13)

where  $f_C$  is in kHz,  $C_O$  (actual capacitance at 5.35 V DC bias) is in  $\mu F$ , and  $R_Z$  is in  $k\Omega$ . The  $gm_{POWER}$  (in A/V) and  $gm_{EA}$  (in  $\mu A/V)$  can be found in the Electrical Characteristic table.

The series capacitor,  $C_Z$ , along with the resistor,  $R_Z$ , set the location of the compensation zero. This zero should be placed no lower than  $\frac{1}{4}$  the crossover frequency and should be kept to a minimum value. Equation 14 can be used to estimate this capacitor value.

$$C_Z > \frac{4}{2\pi \times R_Z \times f_C} \tag{14}$$

where  $f_C$  is in kHz,  $R_Z$  is in k $\Omega$ , and  $C_Z$  is in  $\mu$ F.

Determine if the second compensation capacitor  $(C_P)$  is required. It is required if the ESR zero of the output capacitor is located at less than half of the switching frequency or the following relationship is valid:

$$\frac{1}{2\pi \times C_o \times ESR_{co}} < \frac{f_{SW}}{2} \tag{15}$$

If this is the case, then add the second compensation capacitor  $(C_P)$  to set the pole at the location of the ESR zero. Determine the  $C_P$  value by the equation:

$$C_P = \frac{C_{OUT} \times ESR_{CO}}{R_Z} \tag{16}$$

where  $C_0$  is in  $\mu$ F, ESR<sub>CO</sub> is in m $\Omega$ ,  $R_Z$  is in k $\Omega$ , and  $C_Z$  is in pF.

An Excel-based design tool is available from Allegro that accepts customer specifications and recommended values for both power and compensation components. The pre-regulator bode plot in Figure 9 was generated with this tool. The bandwidth of this system ( $f_C$ ) is 56 kHz, the phase margin (PM) is 67 degrees, and the gain margin (GM) is 21 dB.



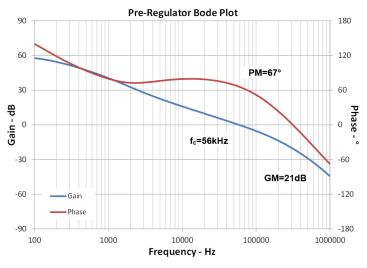


Figure 9: Bode Plot for Pre-Regulator  $R_Z$  = 18.2 k $\Omega$ ,  $C_Z$  = 3.3 nF,  $C_P$  = 47 pF  $L_O$  = 4.7 µH,  $C_O$  = 3 × 10 µF (16V/X7R/1206) MLCC

### **Linear Regulators**

The four linear regulators only require a single ceramic capacitor located near ARG82801 terminals to ensure stable operation. The range of acceptable values is shown in the Electrical Characteristics table. A 2.2  $\mu$ F capacitor per regulator is recommended.

Also, since the V5P1 and V5P2 are used to power remote circuitry, their load may include external wiring. The inductance of this wiring may cause LC-type ringing and negative spikes on the V5P1 (V5P2) pin if a fast short-to-ground occurs. It is recommended a small Schottky diode be placed close to the V5P1 (V5P2) pin to clamp this negative spike. The MSS1P5 (or equivalent) is a good choice.

## Internal Bias (VCC)

The internal bias voltage should be decoupled at the VCC pin using a 1  $\mu F$  ceramic capacitor. It is not recommended to use this pin as a source.

## Signal Pins (NPOR, FFn, POE)

The ARG82801 has many signal level pins. The NPOR, FFn, and ENBAT are open-drain outputs and require external pull-up resistors. Allegro recommends sizing the external pull-up resistors so each pin sinks less than 2 mA when it is a logic low. The POE signal is push-pull output and does not require external pull-up resistor.



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#### PCB LAYOUT RECOMMENDATIONS

The input ceramic capacitors must be located as close as possible to the VIN pins. In general, the smaller capacitors (0402, 0603) must be placed very close to the VIN pin. The larger capacitors should be placed within 0.5 inches of the VIN pin. There must not be any vias between the input capacitors and the VIN pins.

The pre-regulator asynchronous diode (D1), input ceramic capacitors, and RC snubber must be routed on one layer and star grounded at a single location with multiple vias.

The pre-regulator output inductor (L1) should be located close to the LX pins. The LX trace widths (to L1, D1) should be relatively wide and preferably on the same layer as the IC.

The pre-regulators output ceramic capacitors should be located near the VREG pin. There must be 1 or 2 smaller ceramic capacitors as close as possible to the VREG pin.

The four charge pump capacitors must be placed as close as pos-

sible to VCP1, CP1C1/CP1C2 and VCP2, CP2C1/ CP2C2.

The ceramic capacitors for the LDOs (VUC, V5C, V5P1, and V5P2) must be placed near their output pins. The V5P1 and V5P2 outputs must have a 1 A/40 V Schottky diode located very close to their pins to limit negative voltages.

The VCC bypass capacitor must be placed very close to the VCC pin.

The COMP network of pre-regulators  $(R_Z, C_Z, and C_P)$  must be located very close to the COMP pin.

The thermal pad under the ARG82801 must connect to the ground plane(s) with multiple vias.

The boost MOSFET (Q1) and the boost diode (D2) must be placed very close to each other. Q1 should have thermal vias to a polygon on the bottom layer. Also, there should be local bypass capacitors from D2 cathode to Q1 source.



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#### PACKAGE OUTLINE DRAWING

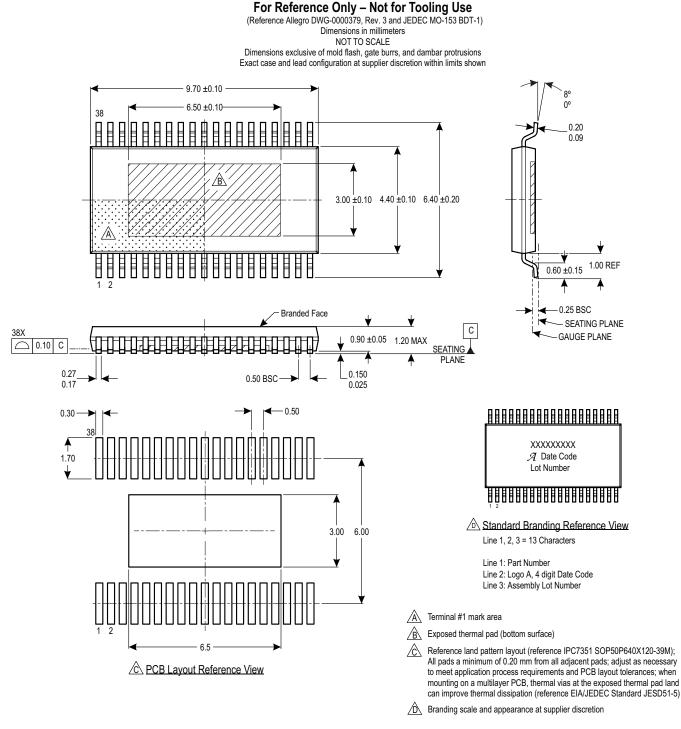


Figure 10: Package LV, 38-Pin eTSSOP





#### **Revision History**

Number	Date	Description
-	March 6, 2018	Initial release
1	April 23, 2018	Corrected selection guide
2	May 2, 2018	Corrected POE_OK fault register (page 30)
3	May 14, 2019	Minor editorial updates
4	June 6, 2022	Updated package drawing (page 43) and minor editorial updates
5	October 20, 2022	Updated Functional Block Diagram (page 4), V5P1 and V5P1 Accuracy and Load Regulation test conditions (page 9), Figure 2 (page 17), Table 2 (page 20), and 0x04 V5P2_UV (page 32)
6	October 21, 2024	Updated registers to current standard (uppercase) (pages 29-37) and minor editorial updates

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